

Renesas RA Family

Getting Started with CoreMark Benchmarking

Introduction

As processors in embedded systems become more complex, more sophisticated benchmarks are needed for a better understanding of performance and analysis.

CoreMark is a modern and sophisticated benchmark that is recommended by ARM® and allows you to accurately measure the performance of a processor. Rather than using arbitrary and synthetic code, CoreMark uses basic data structures and algorithms that are common in any embedded application.

Using CoreMark is encouraged due to its ANSI C compliance and the fact that it is designed to ensure that compilers cannot pre-compute numbers to influence the results and also so that it does not make any library calls during the benchmarked portion of the code.

Running CoreMark produces a single-number score allowing users to make quick comparisons between processors. Results can be uploaded to the CoreMark website for certification as CoreMark has a standard format for reporting results.

This document aims to present and explain the results and the process of benchmarking Renesas RA MCUs using CoreMark.

This application note walks you through all the steps necessary to benchmark using CoreMark.

Required Resources

Development tools and software

- e² studio v2023-01
- Renesas Flexible Software Package (FSP) v4.3.0
- Arm Compiler 6.15
- IAR Embedded Workbench v9.32.1

Hardware

- Renesas RA kit: EK-RA6M5

Reference Manuals

- RA Flexible Software Package Documentation Release v4.3.0
- User's Manual: Renesas RA6M5 Group User's Manual Rev.1.10
- Schematics: EK-RA6M5-v1.0

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1. CoreMark Project

The official CoreMark source is available at EEMBC [GitHub](#). As we plan to use CoreMark on a bare-metal target, the source files we are going to use consist of the following C source and header files:

- coremark.h
- core_main.c
- core_list_join.c
- core_matrix.c
- core_state.c
- core_util.c
- core_portme.c
- core_portme.h
- cvt.c
- ee_printf.c

The three key algorithms used are related to linked lists, matrix multiplication, and state machines.

At EEMBC [GitHub](#) you will also find more information on the rules for building and running the CoreMark code.

The procedure to create a CoreMark project for Renesas RA MCUs is as follows.

- Create a Bare-Metal Minimal Project using e2 studio and Flexible Software Package (FSP)
- Copy CoreMark source code to the "src" folder
- Add a 32-bit general-purpose timer (GPT) to the project
- Change the main stack size setting to 0x4000 to accommodate CoreMark benchmarking
- Exclude the main.c generated by FSP from the build
- Update project optimization with the maximum speed option
- Port core_portme.h, core_portme.c to add necessary code for the GPT
- Port ee_printf.c to print benchmarking result.

This document explains the procedure for EK-RA6M5 but the same can be applied to other RA MCUs.

2. Run CoreMark on Renesas RA MCUs

Apart from the official CoreMark source, in order to be able to replicate exactly the process used in benchmarking the RA MCUs, you will need the e2 studio IDE together with FSP. You can download and install setup_fsp_v4_3_0_e2s_v2023-01.exe from <https://github.com/renesas/fsp/releases>

Moreover, you will need the IAR Arm compiler available at <https://www.iar.com/products/architectures/arm/> and the Arm compiler available at <https://developer.arm.com/documentation/ka005198/latest>. You can use Arm compiler in Keil MDK installation for CoreMark benchmarking.

2.1 Integrating Toolchains with e2 studio

2.1.1 IAR Embedded Workbench Plugin

Download and install IAR Embedded workbench before you integrate IAR compiler with e2 studio.

Start e2 studio, then select "Help -> IAR Embedded Workbench plugin manager"

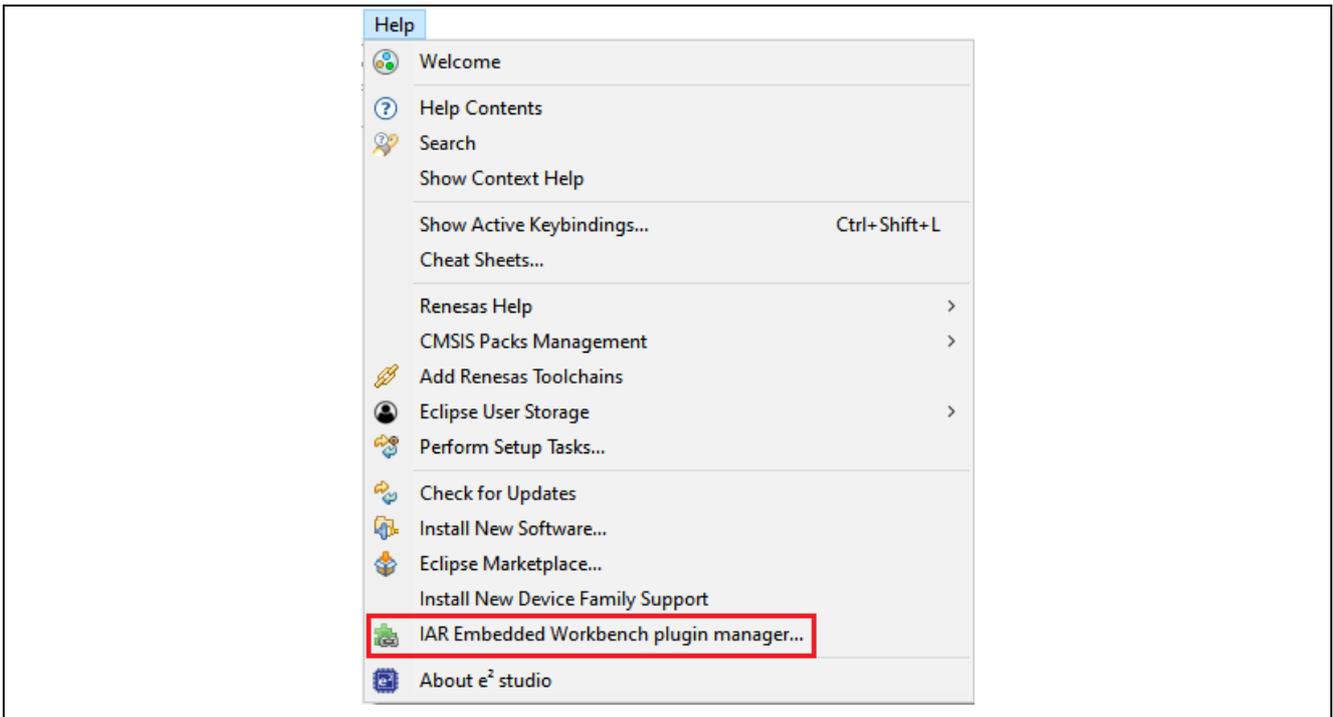


Figure 1. Select IAR Embedded Workbench Plugin Manager

You choose the desired toolchain and press install.

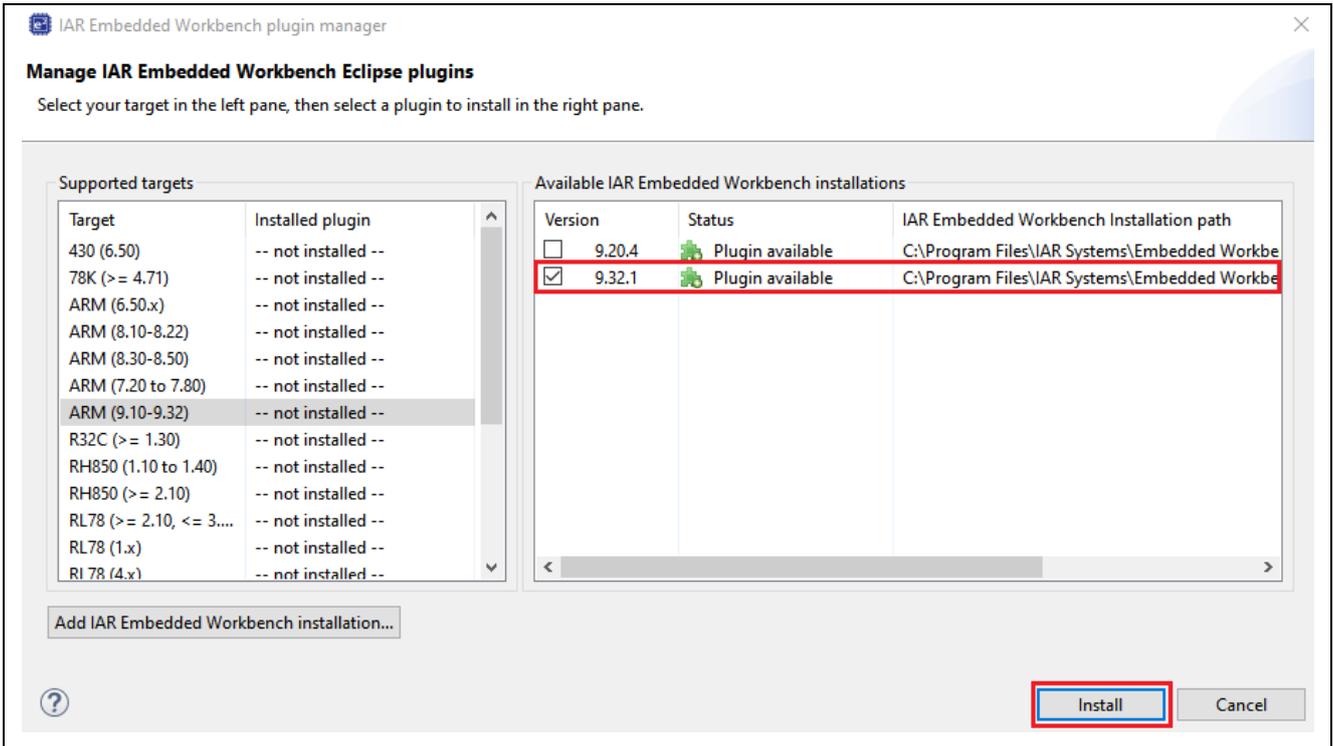


Figure 2. Select IAR Plugin

The bottom right corner of e2 studio IDE will show configuration progress.



Figure 3. IAR Configuration Progress

Press “Next”, then “Next”. Accept the terms of the license agreements then click “Finish”.

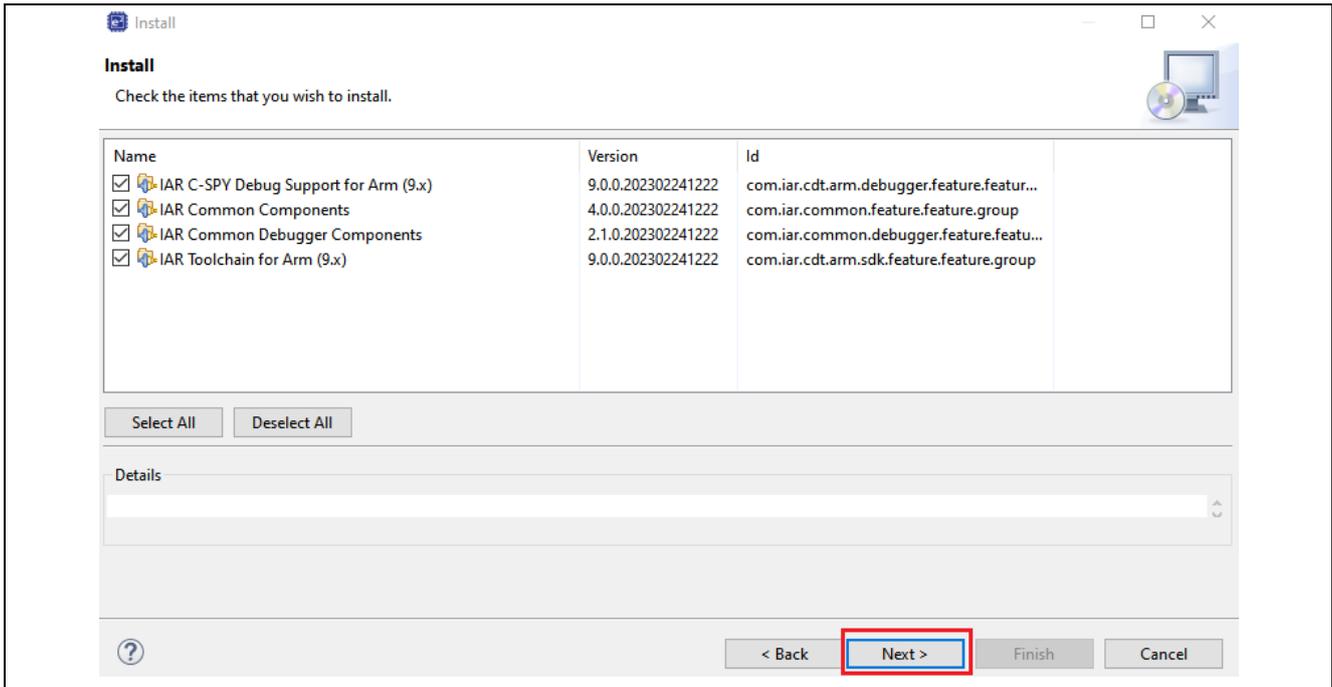


Figure 4. Install IAR Embedded Workbench Plugin

The bottom right corner of e2 studio IDE will show the installation progress.

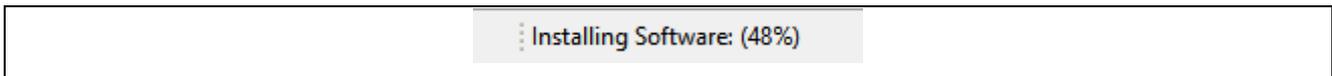


Figure 5. IAR Plugin Installation Process

Wait for the plugin to be installed and click “Restart Now” to complete the installation process.

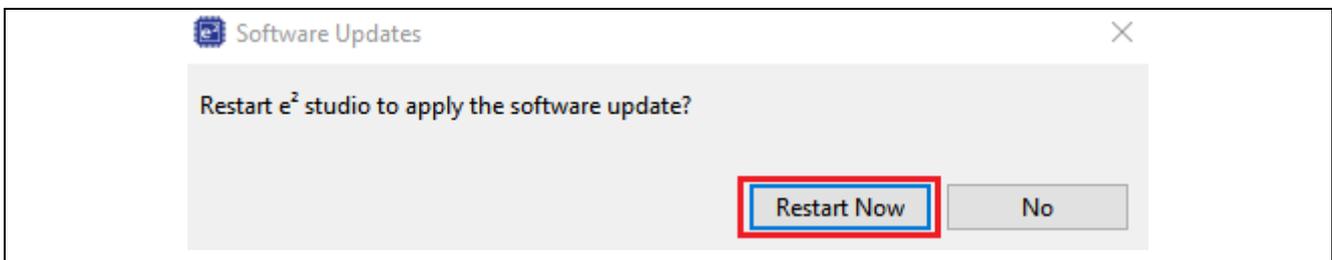


Figure 6. Restart e2 studio

2.1.2 Integrate with Arm Compiler

Download and install Arm compiler or Keil MDK before you integrate Arm compiler with e2 studio.

Start e2 studio, then select “Window -> Preferences” to add toolchains to e2 studio.

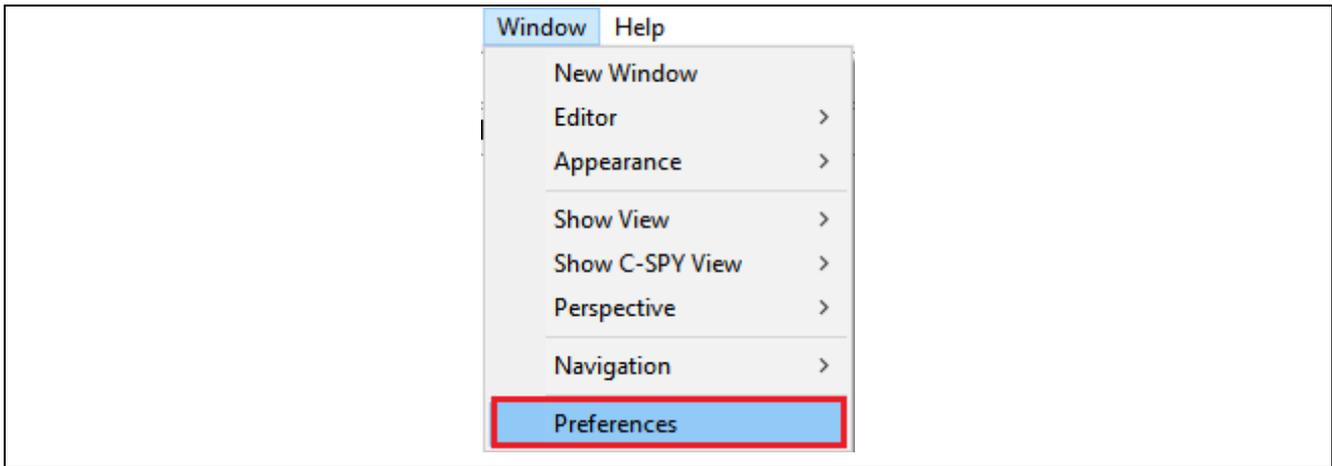


Figure 7. e2 studio Preferences

Select the desired Arm Compiler toolchain, then click “Apply and Close” to add the Arm compiler to e2 studio.

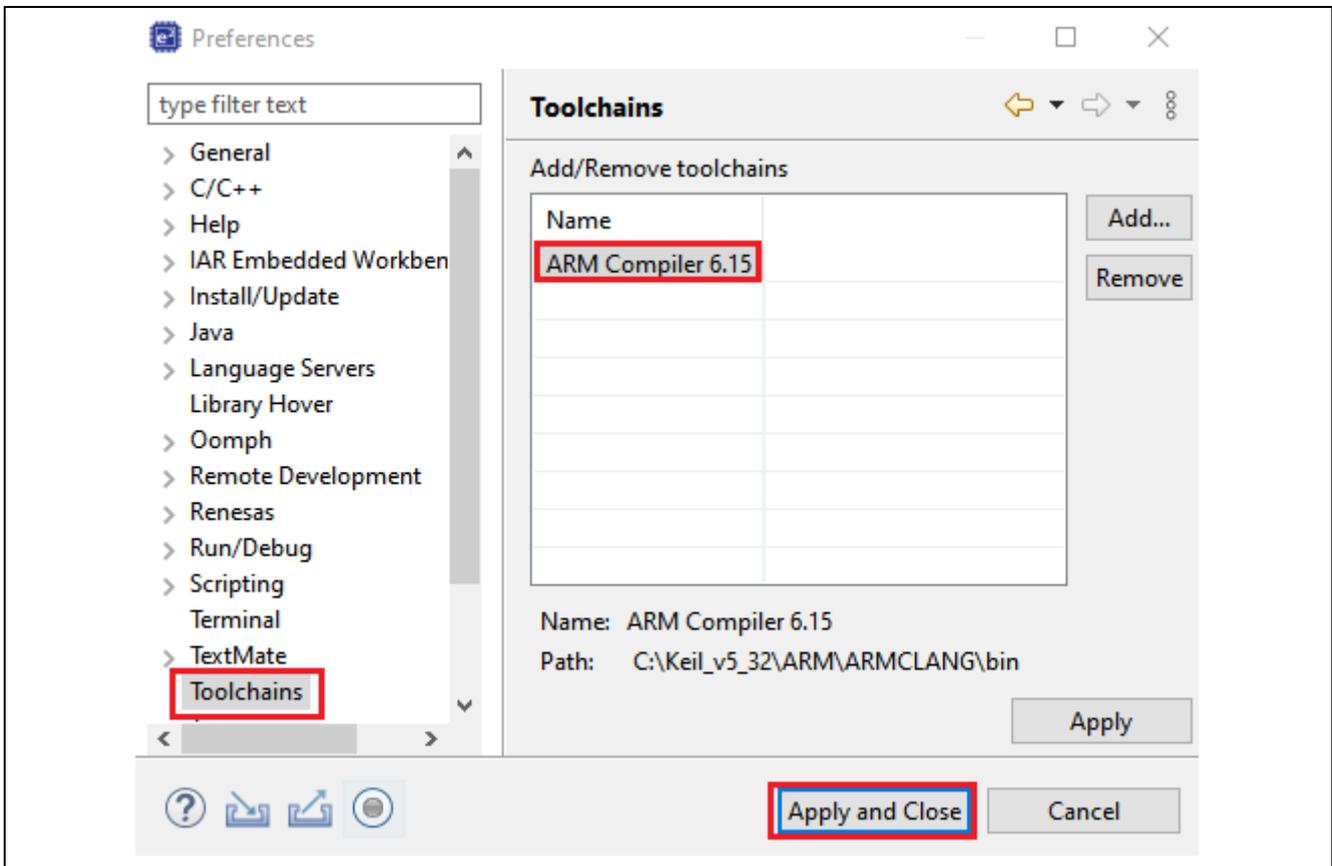


Figure 8. Add Arm Compiler to e2 studio

If Arm compiler is not present in the Toolchains windows, click “Add”, then browse to the toolchain folder, e.g., C:\Keil_v5\ARM\ARMCLANG\bin

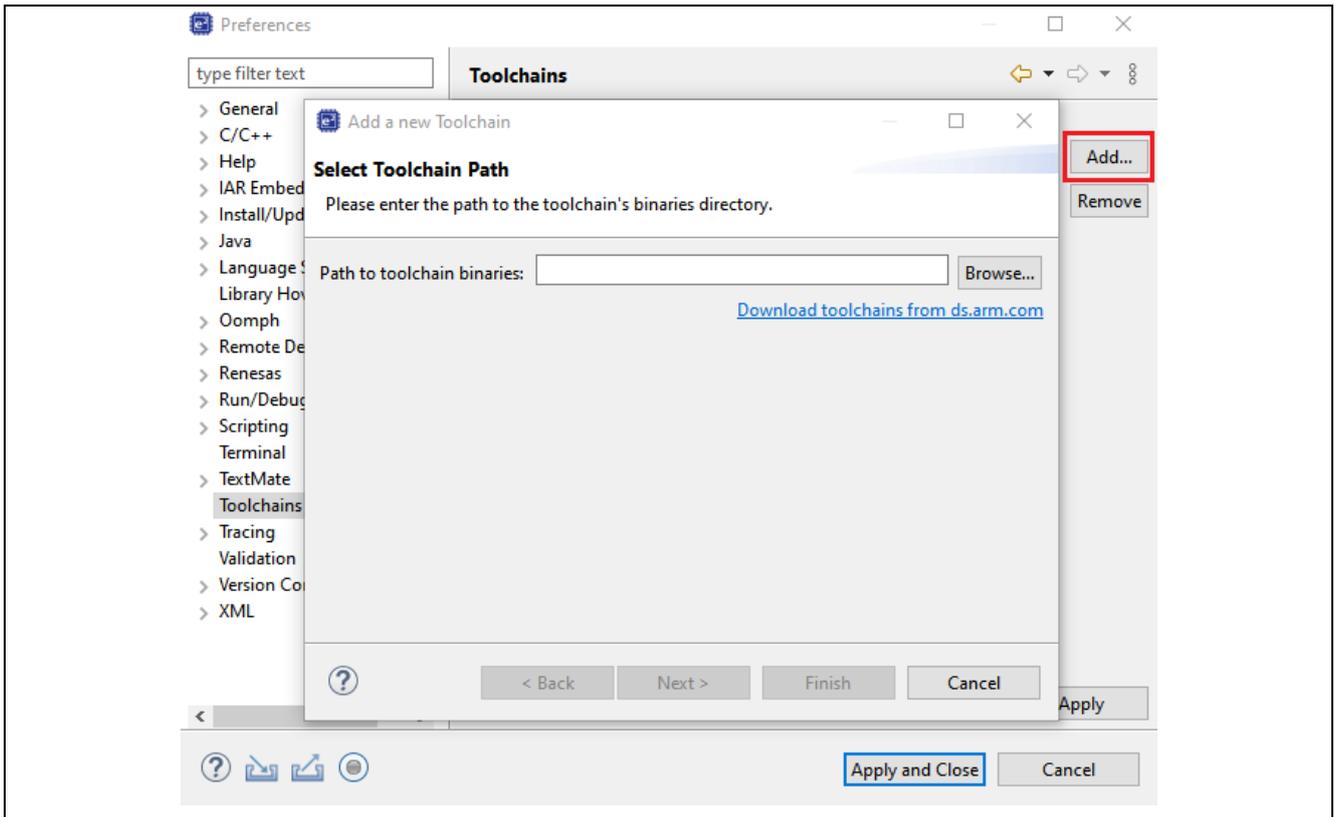


Figure 9. Add Toolchain’s Path

2.2 Create CoreMark e2 studio Project Used for Benchmarking using IAR Compiler

Ensure you integrated IAR compiler with e2 studio before creating a CoreMark project.

On e2 studio, select “File -> New-> C/C++ Project, then click “Next”.

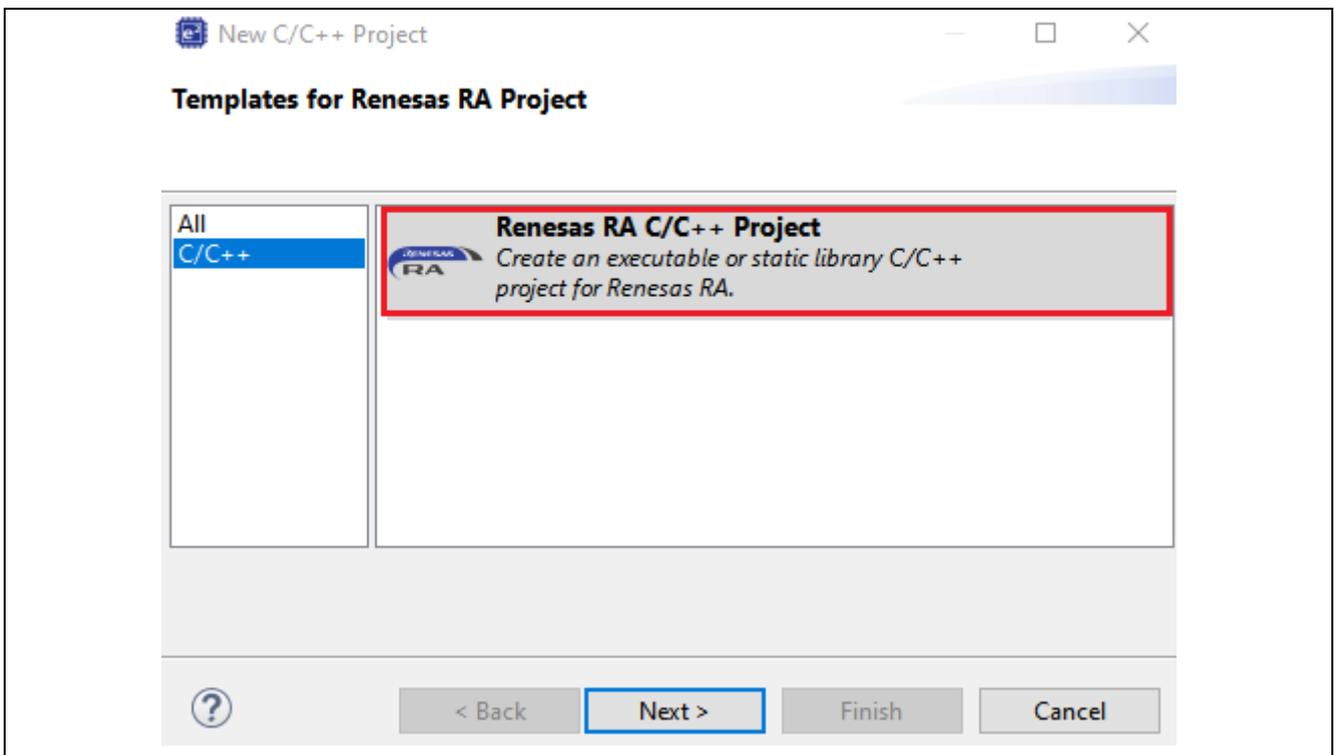


Figure 10. Select C/C++ Template

Name your project an appropriate name, e.g., RA6M5_CoreMark_IAR for EK-RA6M5 kit using IAR compiler.

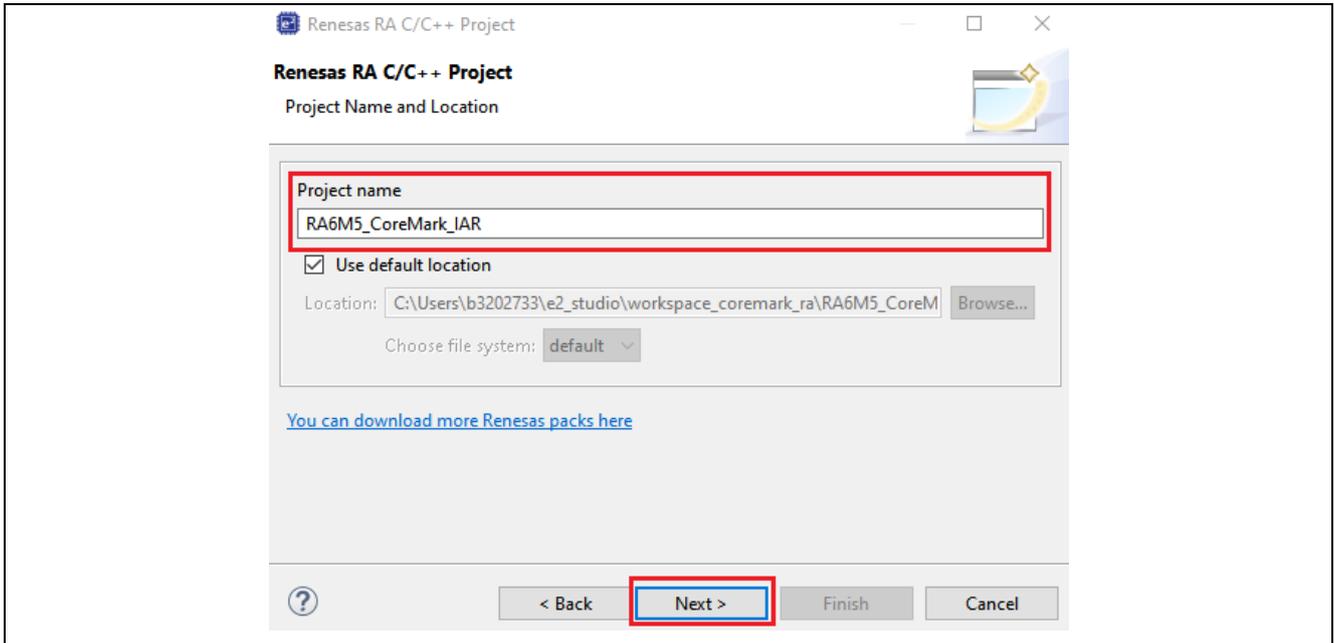


Figure 11. Name Your Project

Select the Board, Device, and Toolchain you want to use for benchmarking.

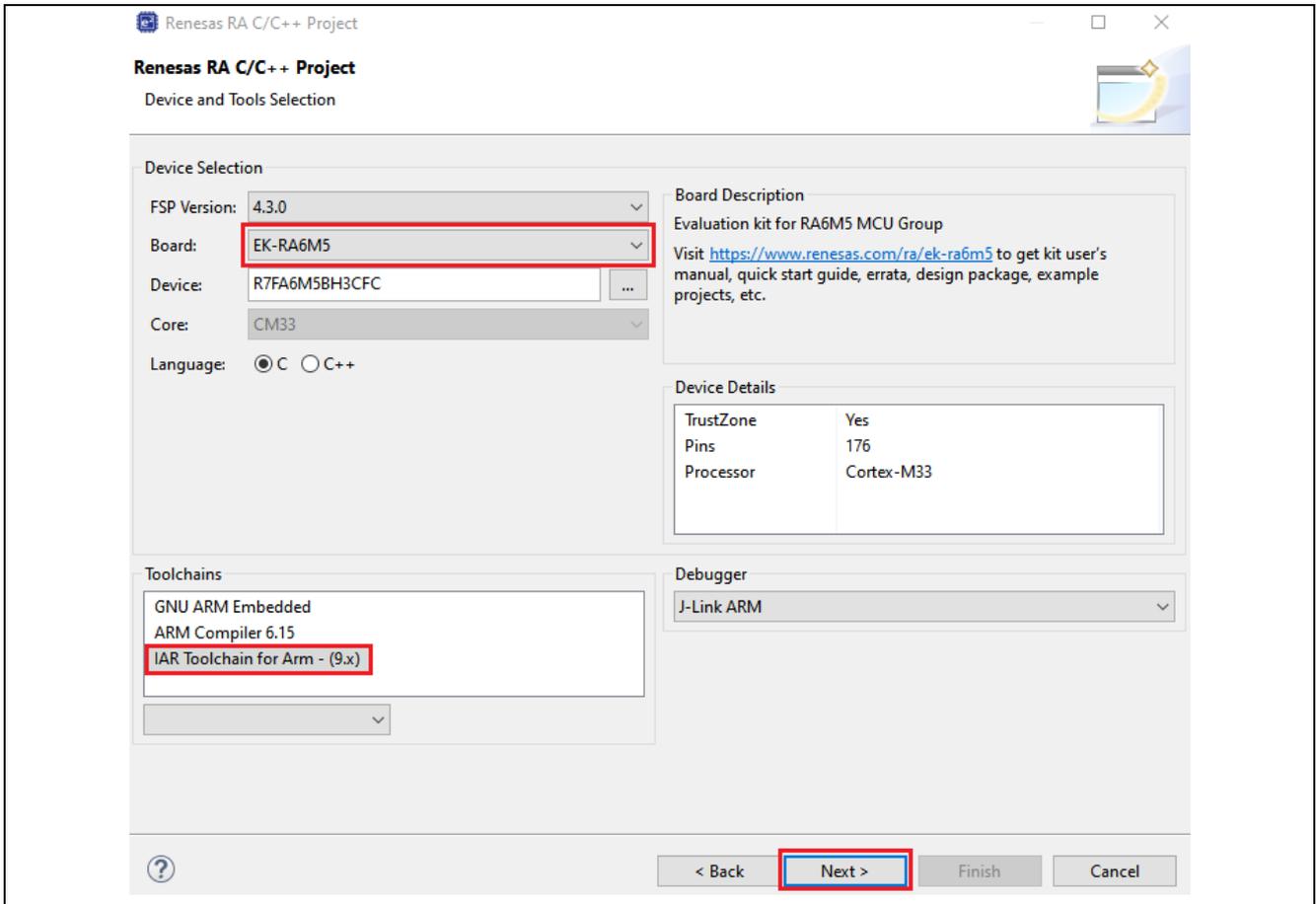


Figure 12. RA Project Options

Select Flat (Non-TrustZone) Project.

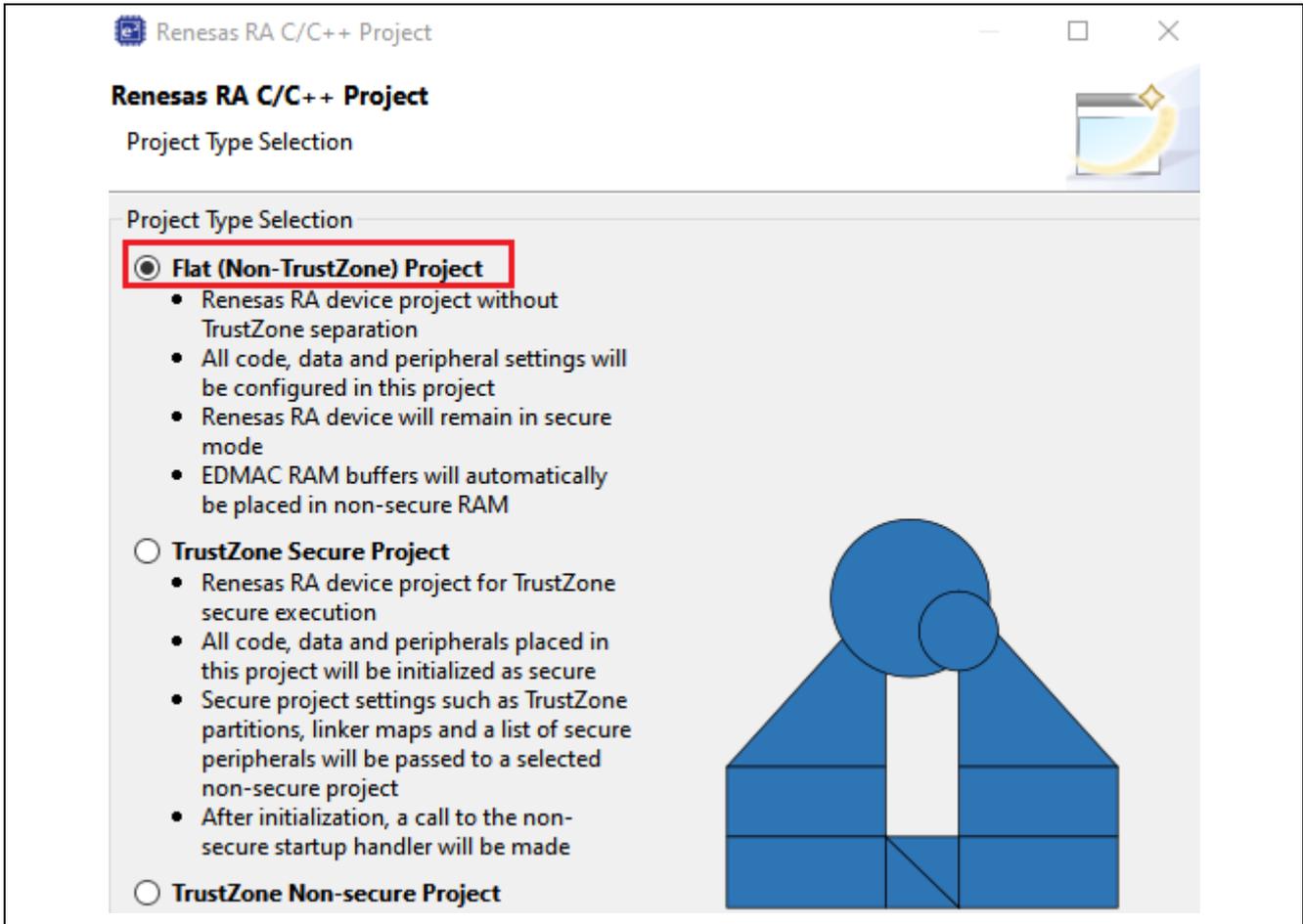


Figure 13. Flat Project Selection

After this step, select Executable project type with No RTOS.

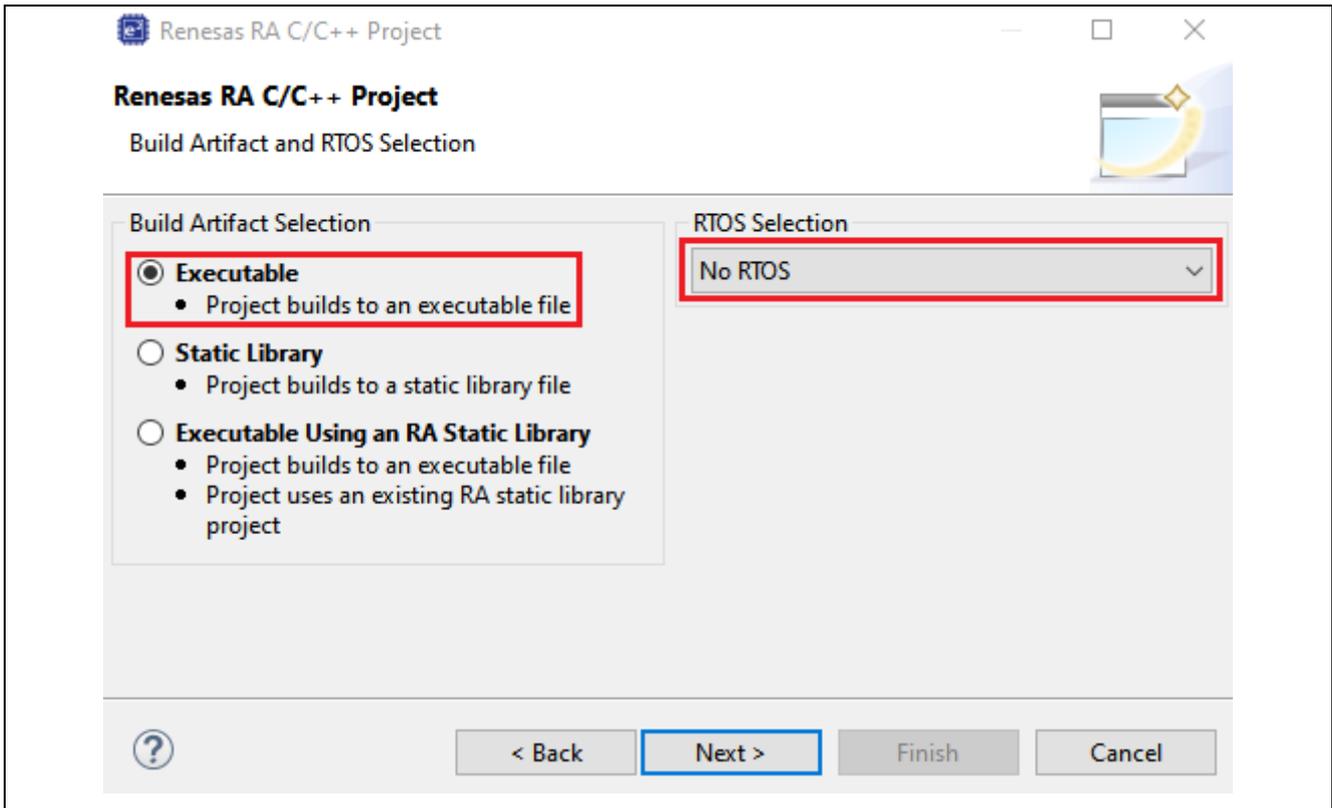


Figure 14. Select No RTOS Project

Select Bare Metal – Minimal Project Template. Click “Finish” to generate the project.

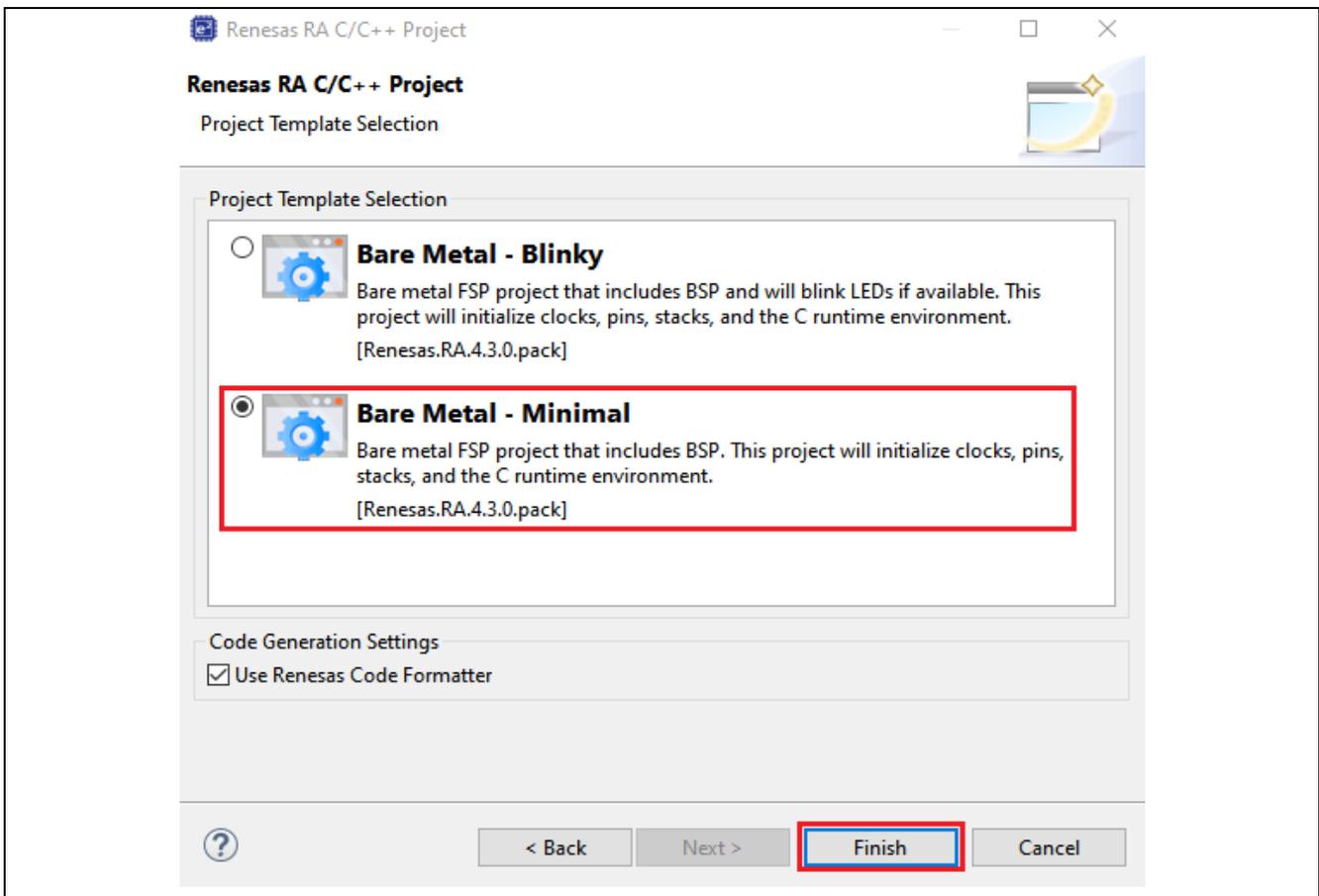


Figure 15. Bare Metal Minimal Option

2.3 Add CoreMark to e2 studio Project

Copy CoreMark source code to the “src” folder in your newly created project. The project structure should look as follows.

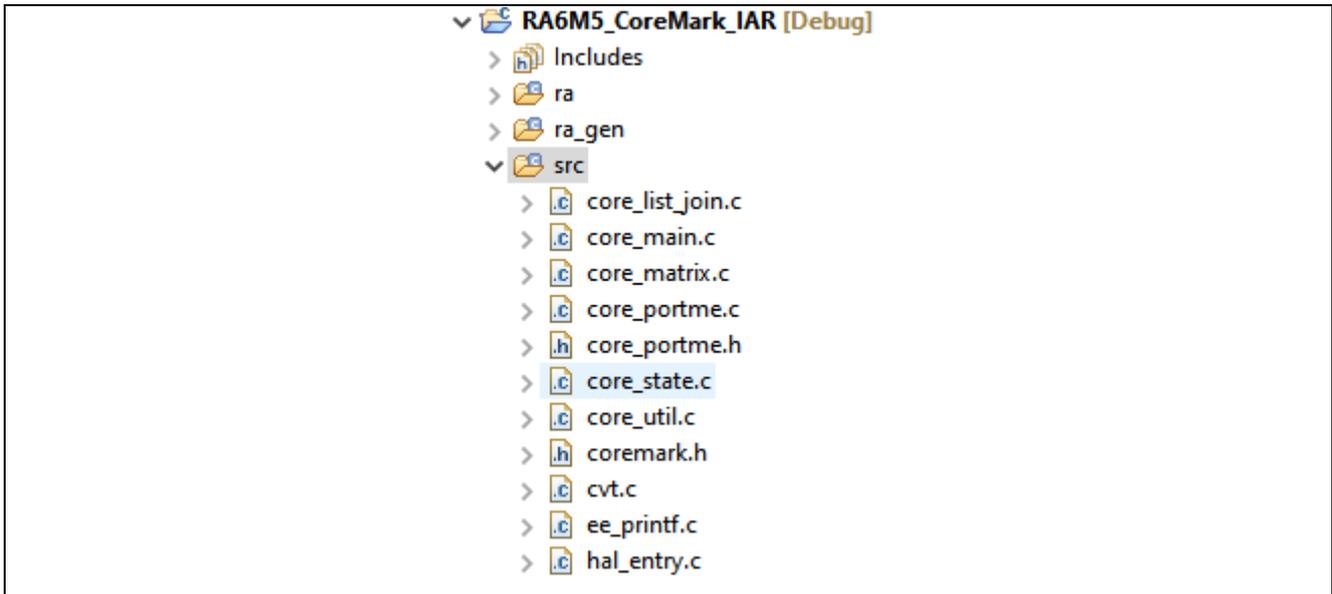


Figure 16. CoreMark Project

You now need to add a periodic timer and modify the core_portme.c source file in order to use the modified barebones_clock(), portable_init(core_portable *p, int *argc, char *argv[]) and portable_fini(core_portable *p) functions.

To add a new periodic timer, open the configuration.xml file and go to Stacks. You should see something similar to the picture below.

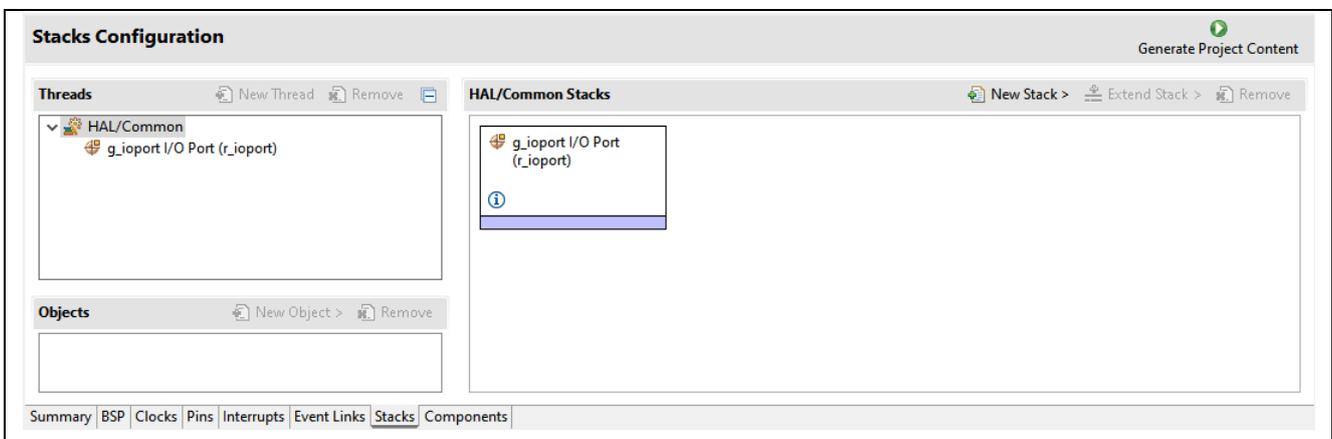


Figure 17. Stack Configuration

2.4 Add Timer for Benchmarking

The next step is to add a New Stack, then select Timers and, finally Timer, General PWM(r_gpt).

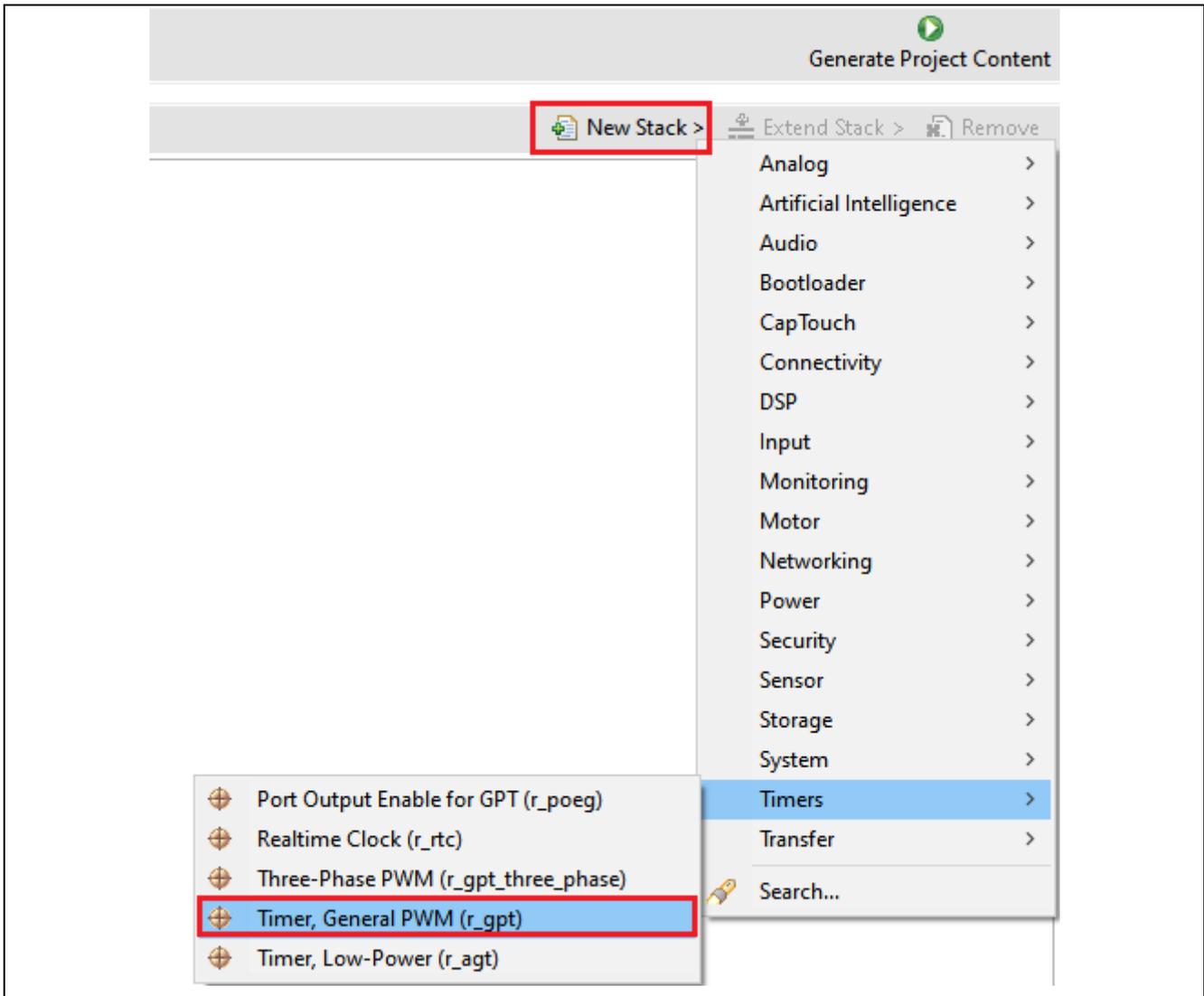


Figure 18. Add GPT Timer

After adding the GPT timer, you need to edit the settings. Clicking on the block representing the newly added GPT timer, then go to Properties Window. You use this Properties window to change the timer’s name to `g_timer_periodic`, the period to 50, and the period unit to Seconds. You also need to expand the Interrupts block, add the Callback as `timer_callback` and set the Priority to 2. The following image captures the changes needed.

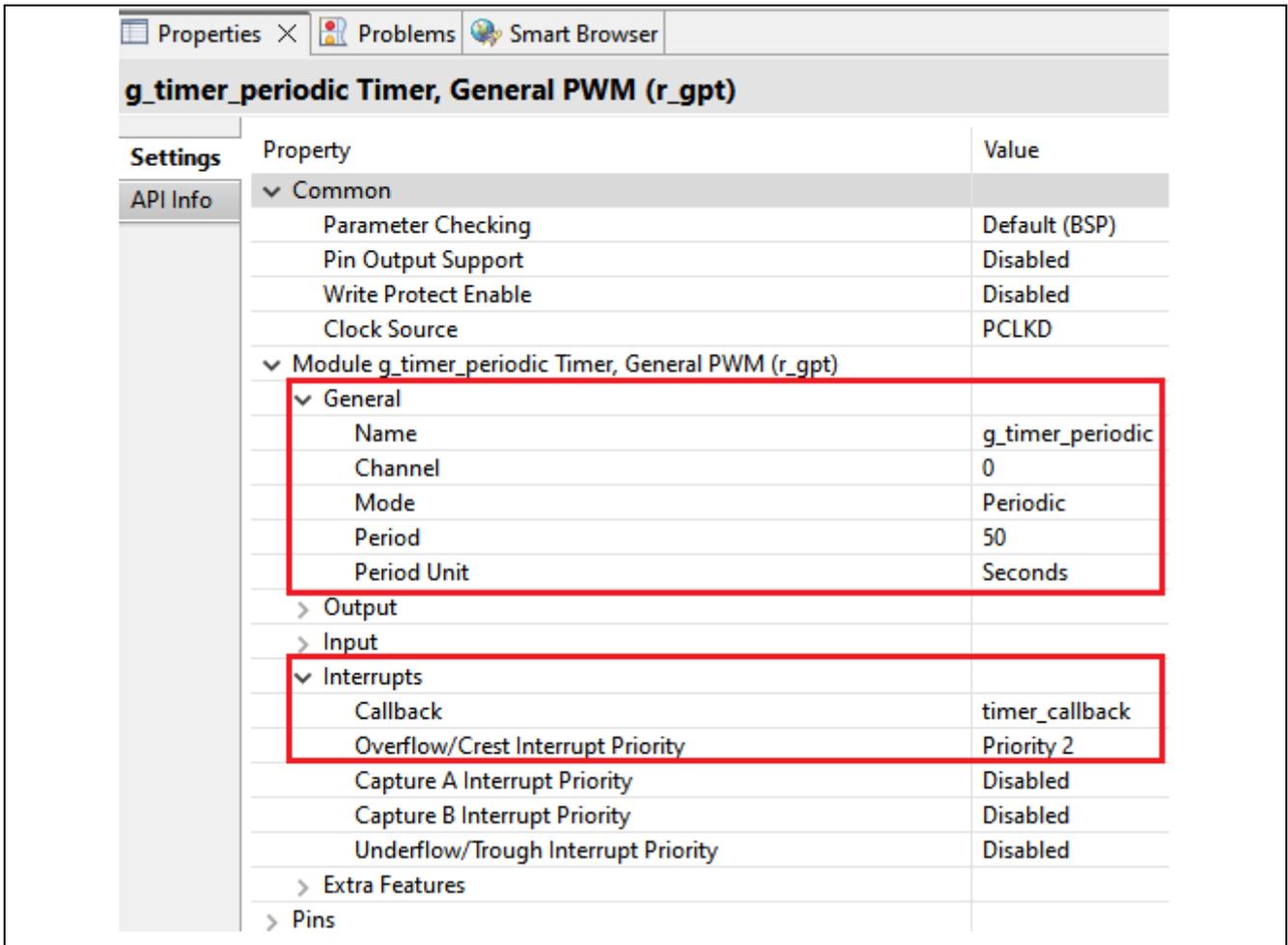


Figure 19. GPT Configuration

2.5 Update Main Stack

Change the Main Stacks Size in BSP properties to 0x4000.

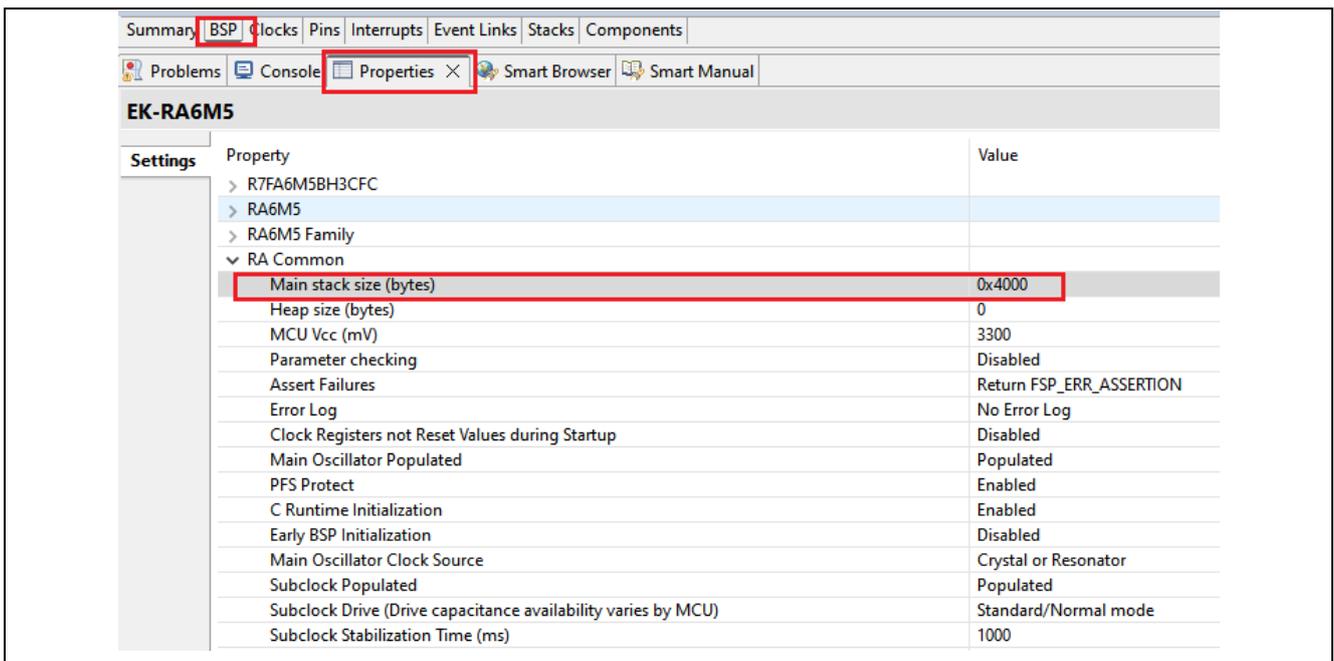


Figure 20. Change Main Stack Size

Click “Generate Project Content”, then the next step is to modify the source files.

Right click on the ra_gen\main.c and exclude it from the Build, so there is no conflict with the main from core_main.c.

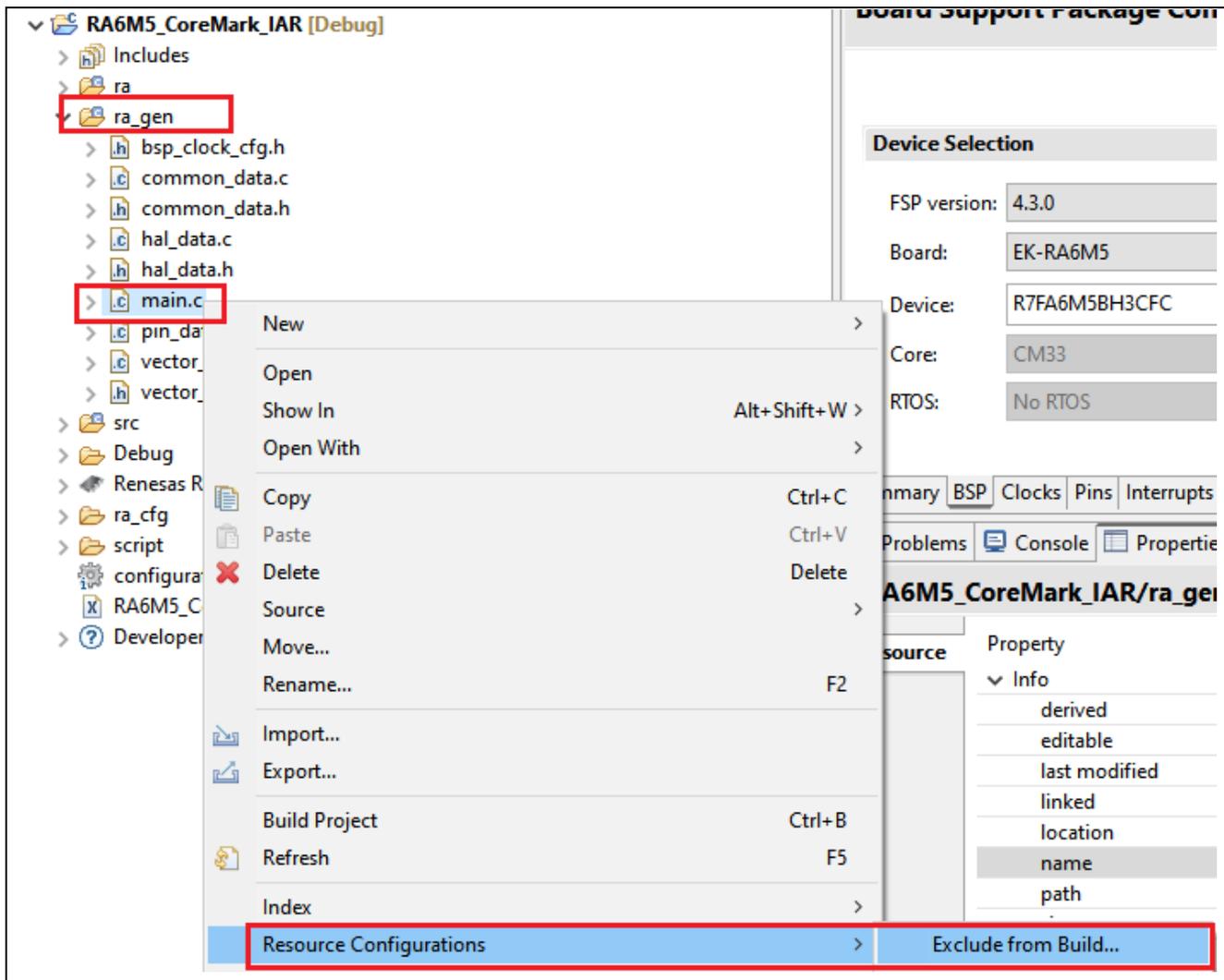


Figure 21. Exclude main.c from Build

2.6 Port CoreMark Code

You modify the core_portme.h and the core_portme.c in the “src” folder.

In core_portme.h, add “#include <stddef.h>” before the code “typedef size_t ee_size_t;”, as shown below.

```

/* Data Types :
   To avoid compiler issues, define the data types that need ot be used for
   8b, 16b and 32b in <core_portme.h>.

   *Imprtant* :
   ee_ptr_int needs to be the data type used to hold pointers, otherwise
   coremark may fail!!!
*/
typedef signed short    ee_s16;
typedef unsigned short ee_ul6;
typedef signed int     ee_s32;
typedef double         ee_f32;
typedef unsigned char  ee_u8;
typedef unsigned int   ee_u32;
typedef ee_u32         ee_ptr_int;
#include <stddef.h>
typedef size_t         ee_size_t;
#define NULL ((void *)0)

```

Figure 22. Add “#include <stddef.h>”

Also, in core_portme.h, modify the “#define COMPILER_FLAGS” depending on the toolchain used. If you use IAR Compiler version 9.32.1, change it to #define COMPILER_FLAGS “High Speed; No size constraints”.

The code should look as follows.

```

/* Definitions : COMPILER_VERSION, COMPILER_FLAGS, MEM_LOCATION
   Initialize these strings per platform
*/
#ifndef COMPILER_VERSION
#ifdef __GNUC__
#define COMPILER_VERSION "GCC" _VERSION_
#else
#define COMPILER_VERSION "IAR Compiler v9.32.1"
#endif
#endif
#ifndef COMPILER_FLAGS
#define COMPILER_FLAGS "High Speed; No size constraints"
#endif
#ifndef MEM_LOCATION
#define MEM_LOCATION "STACK"
#endif

```

Figure 23. Modify core_portme.h

In core_portme.c, before the barebones_clock() function, add below code.

```

volatile ee_s32 seed4_volatile = ITERATIONS;
volatile ee_s32 seed5_volatile = 0;

/* Since we set the timer period to 50s, the actual value is 50000000 with the counter clock at 100MHz/2 */
#define CLOCKS_PER_SEC 50000000
timer_info_t g_timer_info;
uint32_t g_capture_overflows = 0U;

```

Figure 24. Modify core_portme.c

You can check and correct the CLOCKS_PER_SEC setting by getting the correct value from the clock_frequency, shown in the figure below when running the project for the first time.

```

err = R_GPT_Start(&g_timer_periodic_ctrl);
if (FSP_SUCCESS != err)
{
    ee_printf("ERROR: R_GPT_Start!\n");
}
err = R_GPT_InfoGet(&g_timer_periodic_ctrl, &g_timer_info);
if (FSP_SUCCESS != err)
{
    ee_printf("ERROR: R_GPT_InfoGet!\n");
}
if (sizeof(ee_ptr_int) != sizeof(ee_u8 *))
{
    ee_printf(
        "ERROR! Please define ee_ptr_int to a
        pointer!\n");
}
if (sizeof(ee_u32) != 4)
{
    ee_printf("ERROR! Please define ee_u32 to
    a u32!\n");
}
p->portable_id = 1;
}
    
```

Expression	Type	Value	Address
g_timer_info	timer_info_t	{...}	0x20004250
(*) count_direction	timer_direction_t	TIMER_DIRECTION_UP	0x20004250
(*) clock_frequency	uint32_t	50000000	0x20004254
(*) period_counts	uint32_t	2500000000	0x20004258

Name : g_timer_info
 Details: {count_direction = TIMER_DIRECTION_UP, clock_frequency = 50000000, peri
 Default: {...}
 Decimal: {...}
 Hex: {...}
 Binary: {...}

Figure 25. Check CLOCK_PER_SEC Setting

Change the barebones_clock() functions as follows.

```

/* Porting : Timing functions
   How to capture time and convert to seconds must be ported to whatever is
   supported by the platform. e.g. Read value from on board RTC, read value from
   cpu clock cycles performance counter etc. Sample implementation for standard
   time.h and windows.h definitions included.
*/
CORETIMETYPE
barebones_clock()
{
    fsp_err_t err = FSP_SUCCESS;
    timer_status_t status;
    err = R_GPT_StatusGet (&g_timer_periodic_ctrl, &status);
    if (FSP_SUCCESS != err)
    {
        ee_printf("ERROR: R_GPT_StatusGet!\n");
    }
    /* The period is set to 50s we shouldn't overflow but just in case
       report an error if we do. If we set the a shorter period we need to do:
       info.period_counts * g_capture_overflows */
    if(g_capture_overflows > 0)
    {
        ee_printf("ERROR: Timer overflow!\n");
    }
    return status.counter;
}
    
```

Figure 26. bareborns_clock() Function

Then change the portable_fini(core_portable *p), portable_init(core_portable *p, int *argc, char *argv[]) to add the GPT timer that is needed for benchmarking.

```

/* Function : portable_init
   Target specific initialization code
   Test for some common mistakes.
*/
void
portable_init(core_portable *p, int *argc, char *argv[])
{
    fsp_err_t err = FSP_SUCCESS;

    /* Flush C cache */
    uint32_t * c_cache = (uint32_t *)0x40007004;
    *c_cache = 1;
    /* Enable C cache */
    c_cache = (uint32_t *)0x40007000;
    *c_cache = 1;

    /* Flush S cache */
    uint32_t * s_cache = (uint32_t *)0x40007044;
    *s_cache = 1;
    /* Flush S cache */
    s_cache = (uint32_t *)0x40007040;
    *s_cache = 1;

    /* Initialize GPT Timer */
    err = R_GPT_Open(&g_timer_periodic_ctrl, &g_timer_periodic_cfg);
    if (FSP_SUCCESS != err)
    {
        ee_printf("ERROR: R_GPT_Open!\n");
    }
    err = R_GPT_Start(&g_timer_periodic_ctrl);
    if (FSP_SUCCESS != err)
    {
        ee_printf("ERROR: R_GPT_Start!\n");
    }
    err = R_GPT_InfoGet(&g_timer_periodic_ctrl, &g_timer_info);
    if (FSP_SUCCESS != err)
    {
        ee_printf("ERROR: R_GPT_InfoGet!\n");
    }
    if (sizeof(ee_ptr_int) != sizeof(ee_u8 *))
    {
        ee_printf(
            "ERROR! Please define ee_ptr_int to a type that holds a "
            "pointer!\n");
    }
    if (sizeof(ee_u32) != 4)
    {
        ee_printf("ERROR! Please define ee_u32 to a 32b unsigned type!\n");
    }
    p->portable_id = 1;
}

```

Figure 27. portable_init Function

```

    /* Function : portable_fini
       Target specific final code
    */
    void
    portable_fini(core_portable *p)
    {
        fsp_err_t err = FSP_SUCCESS;

        err = R_GPT_Stop(&g_timer_periodic_ctrl);
        if (FSP_SUCCESS != err)
        {
            ee_printf("ERROR: R_GPT_Stop!\n");
        }
        p->portable_id = 0;
        BSP_CFG_HANDLE_UNRECOVERABLE_ERROR(0);
    }

```

Figure 28. portable_fini Function

At the end of the file, add the callback method function of the GPT timer.

```

    /* Example callback called when timer expires. */
    void timer_callback (timer_callback_args_t * p_args)
    {
        if (TIMER_EVENT_CYCLE_END == p_args->event)
        {
            g_capture_overflows++;
        }
    }

```

Figure 29. Add timer_callback to core_portme.c

In ee_printf.c, change the uart_send_char(char c) and add the below code for printing benchmarking results.

```

#define MAXBUFFER 1000
volatile char uart_buffer[MAXBUFFER + 1];
volatile unsigned int uart_buffer_cnt = 0;

void
uart_send_char(char c)
{
    if(uart_buffer_cnt < MAXBUFFER)
    {
        uart_buffer[uart_buffer_cnt++] = c;
        uart_buffer[uart_buffer_cnt] = '\0';
    }
    else
    {
        uart_buffer[uart_buffer_cnt] = '\0';
    }
}

```

Figure 30. Add uart_send_char Function

In the project properties setting, add "ITERATIONS=8000" to IAR C/C++ Compiler for ARM->Preprocessor.

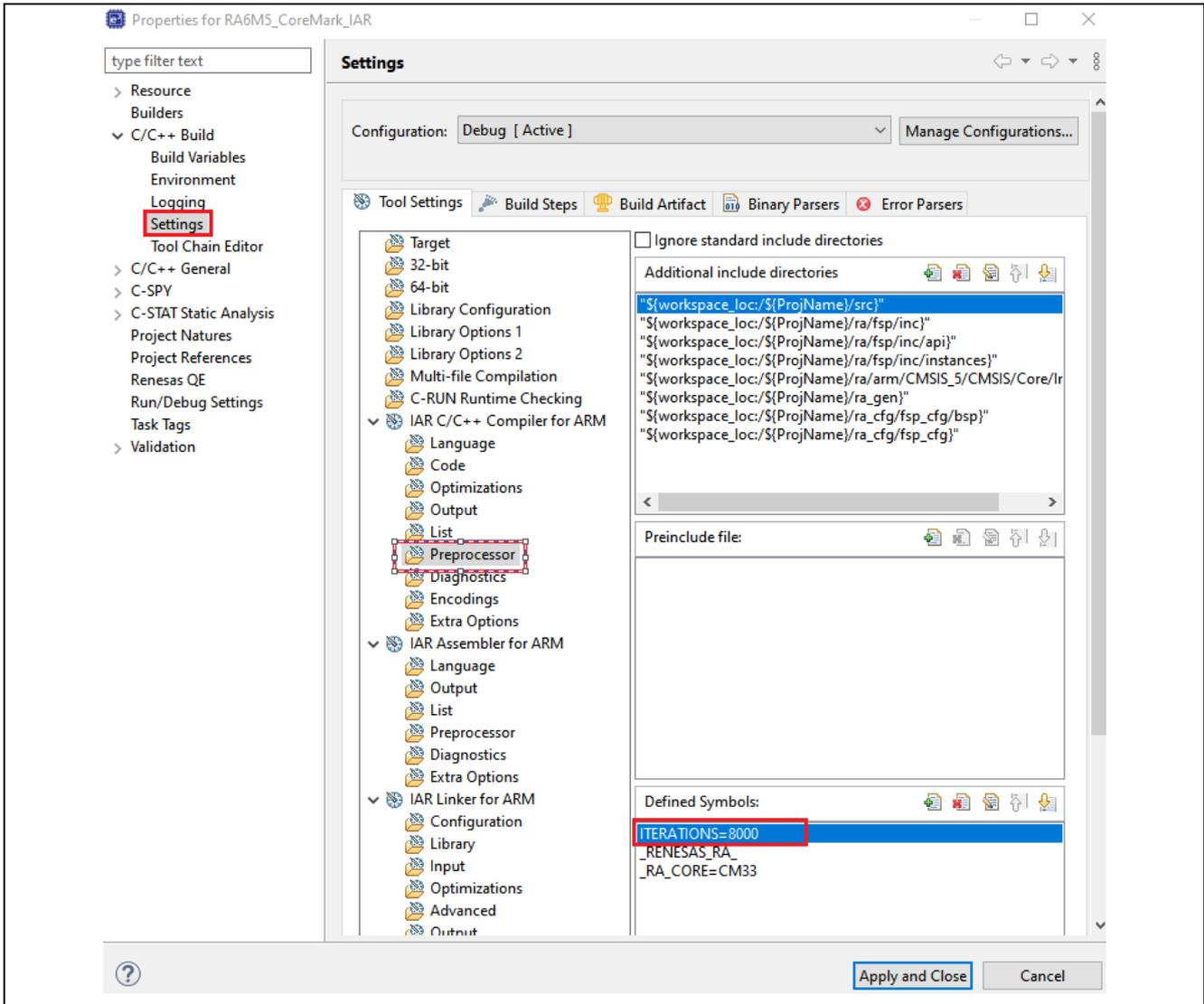


Figure 31. Preprocessor Setting

In the project properties setting, change IAR C/C++ Compiler for ARM->Optimization to "High, Speed" with "No size constraints".

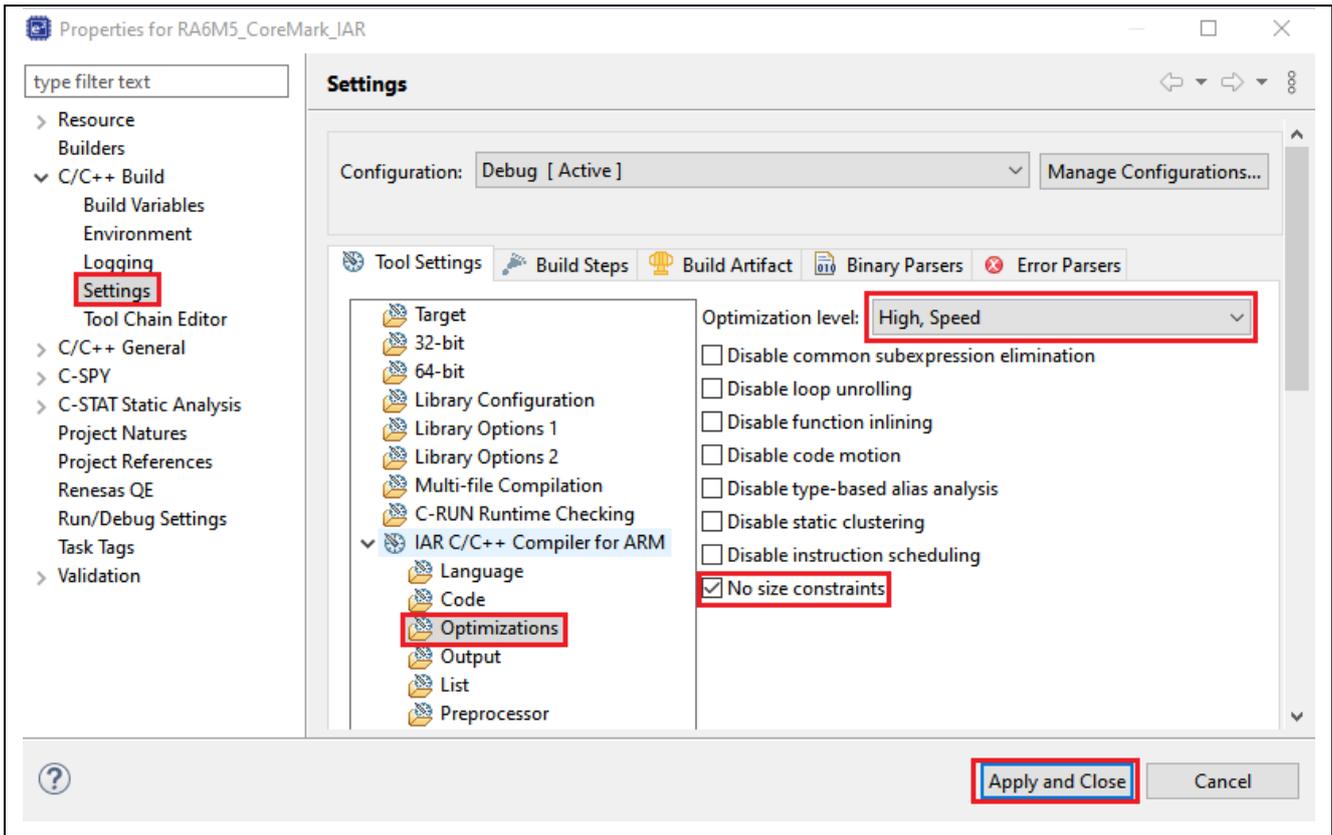


Figure 32. Optimization Setting

Now you can build the project without errors.

2.7 Create CoreMark e2 studio Project Used for Benchmarking using Arm Compiler

Ensure you integrated the Arm compiler with e2 studio before creating a CoreMark project. Select the Board, Device, and Toolchain you want to use for benchmarking and process to create an Arm compiler-based project similar to the IAR compiler. Follows sections 2.3, 2.4, 2.5, and 2.6 to add the GPT module, configure your project, and port the CoreMark. Note that you need a commercial license to use "--lto" option in Arm Compiler.

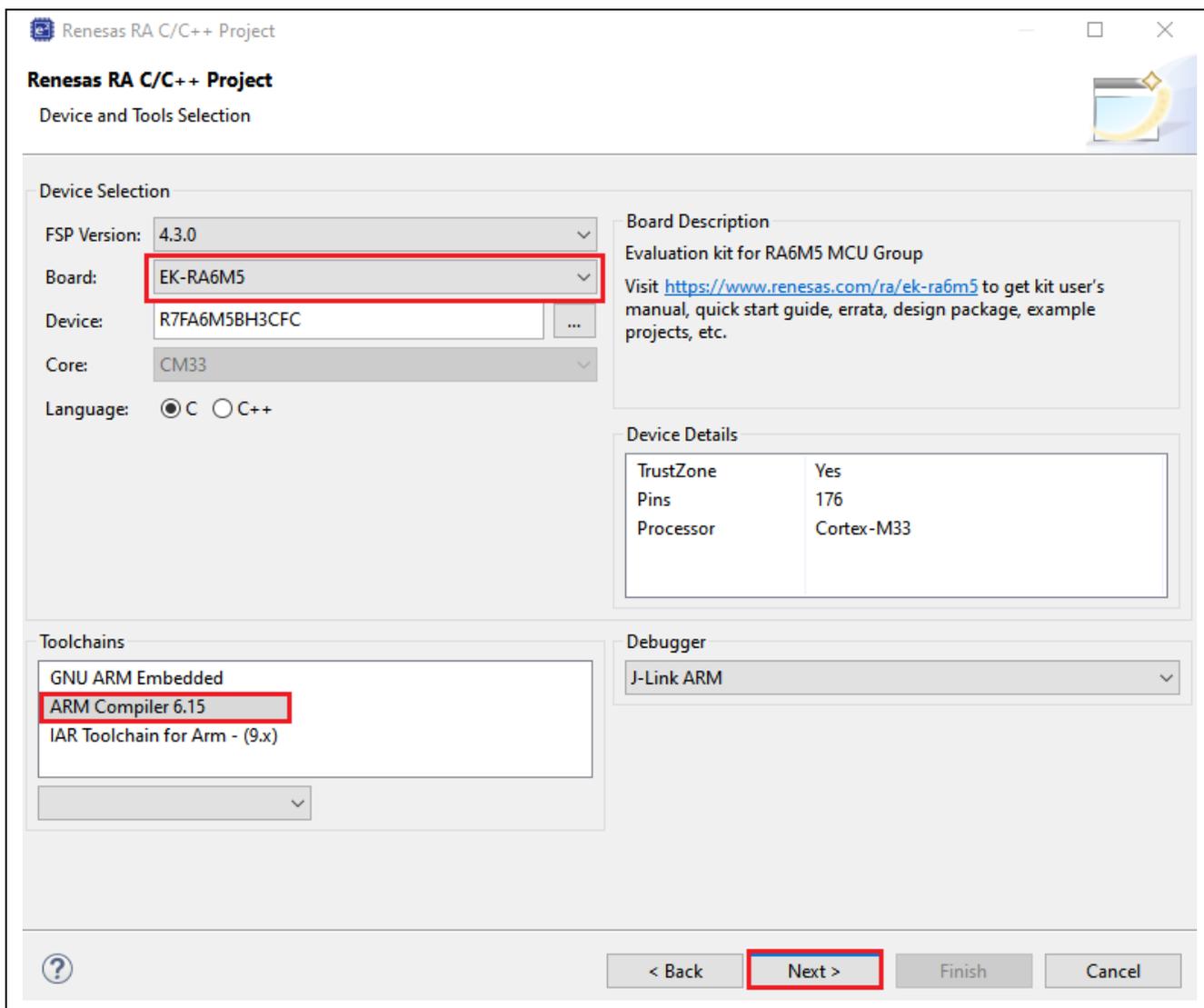


Figure 33. Create An Arm Compiler - Based Project Options

Also, in core_portme.h, modify the "#define COMPILER_FLAGS" depending on the toolchain used. In the case of Arm Compiler, change it to "-Omax".

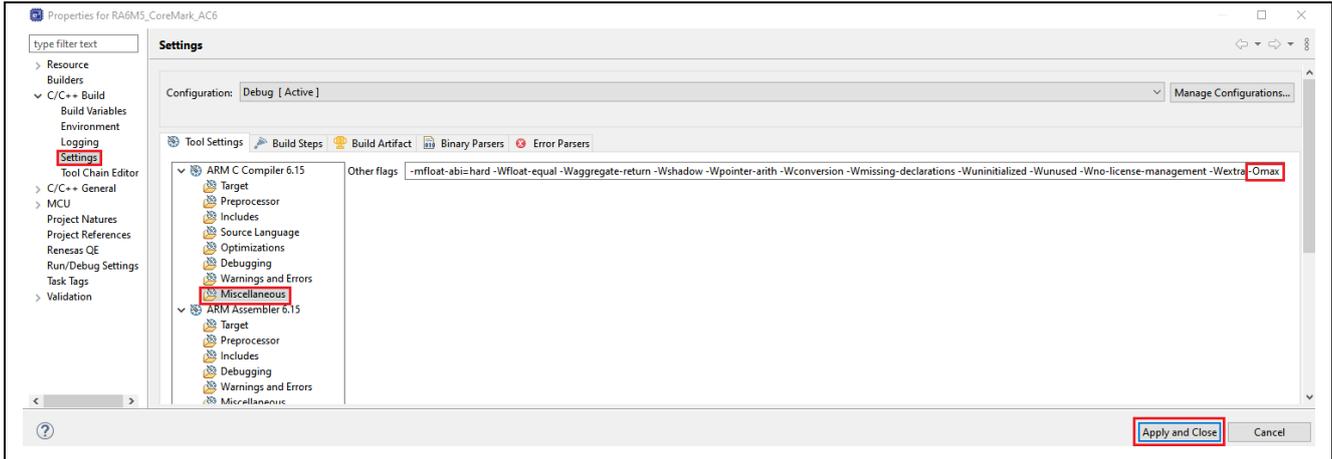
The code should look as follows.

```

/* Definitions : COMPILER_VERSION, COMPILER_FLAGS, MEM_LOCATION
   Initialize these strings per platform
*/
#ifndef COMPILER_VERSION
#ifdef __GNUC__
#define COMPILER_VERSION __VERSION__
#else
#define COMPILER_VERSION "Please put compiler version here (e.g. gcc 4.1)"
#endif
#endif
#ifndef COMPILER_FLAGS
#define COMPILER_FLAGS "-Omax"
#endif
#ifndef MEM_LOCATION
#define MEM_LOCATION "STACK"
#endif
    
```

Figure 34. Modify "#define COMPILER_FLAGS"

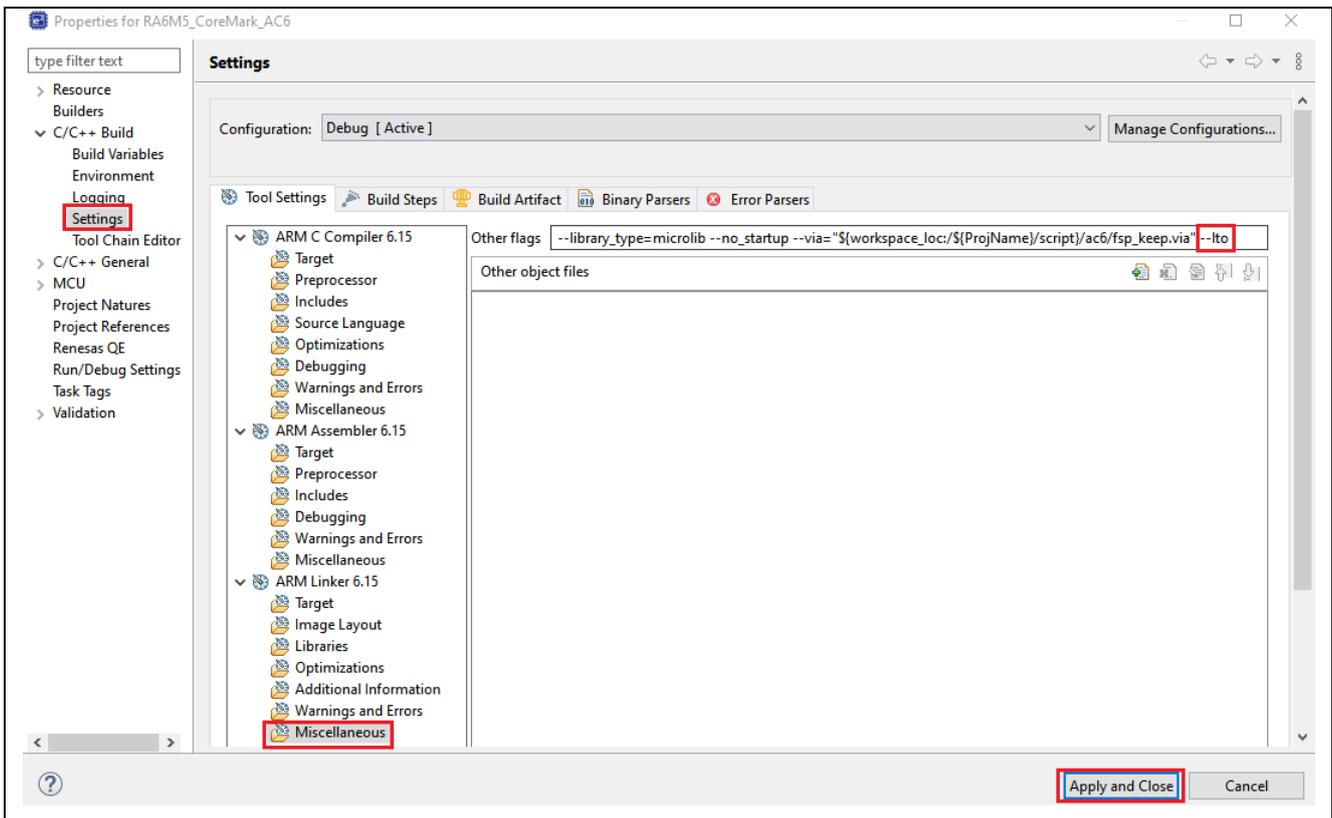
In the project's Properties-> ARM C Compiler 6.15->Miscellaneous->Other flags, add "-Omax".



```
-mfloat-abi=hard -Wfloat-equal -Waggregate-return -Wshadow -Wpointer-arith -Wconversion -Wmissing-declarations -Wuninitialized -Wunused -Wno-license-management -Wextra -Omax
```

Figure 35. Add "-Omax" Option to Project Settings

In the project's Properties-> ARM Linker 6.15->Miscellaneous->Other flags, add "--lto".



```
--library_type=microlib --no_startup --via="{workspace_loc}/{ProjName}/script}/ac6/fsp_keep.via" --lto
```

Figure 36. Add "--lto" Option to Project Settings.

2.8 Run CoreMark Project

2.8.1 Board Setup

The EK-RA6M5 kit has a few switch settings which must be configured before running the projects associated with this application note. In addition to these switch settings, the boards also contain a USB debug port and connectors to access the J-Link® programming interface.

Table 1. Switch settings for EK-RA6M5

Switch	Setting
J8	Jumper on pins 1-2
J9	Open

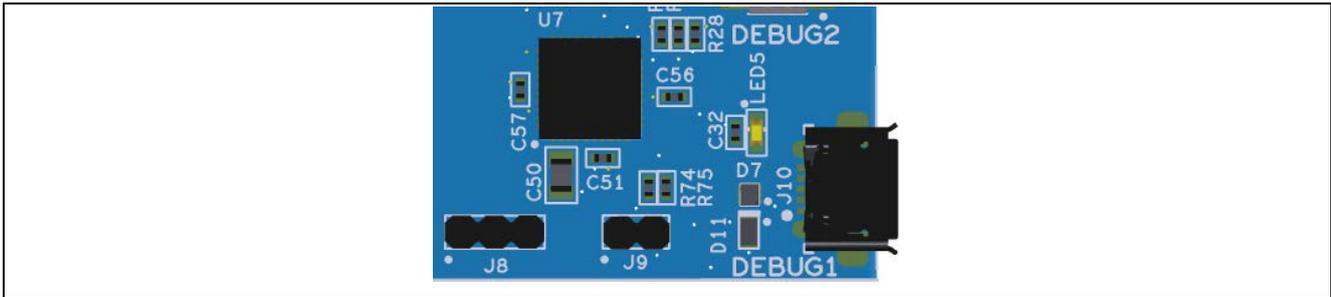


Figure 37. J8 and J9 on EK-RA6M5

The figure below shows the picture of the EK-RA6M5 kit.

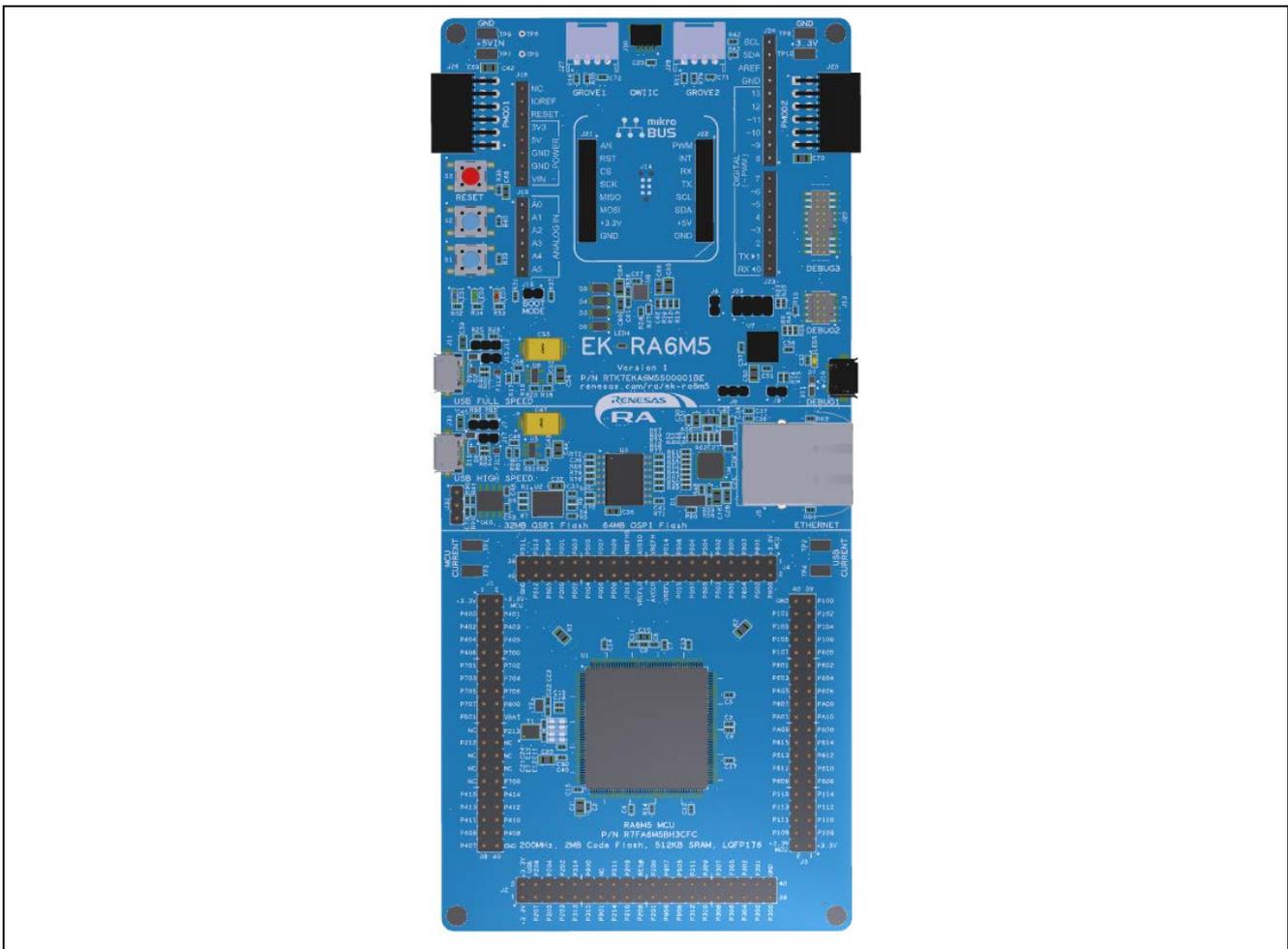


Figure 38. EK-RA6M5

Connect the board to your PC using the USB cable into the port labeled “Debug1”.

2.8.2 Add Run Commands to Print Out Benchmarking Result.

In Debug Configuration, add the below command.

```
dprintf portable_fini,"%s",uart_buffer
```

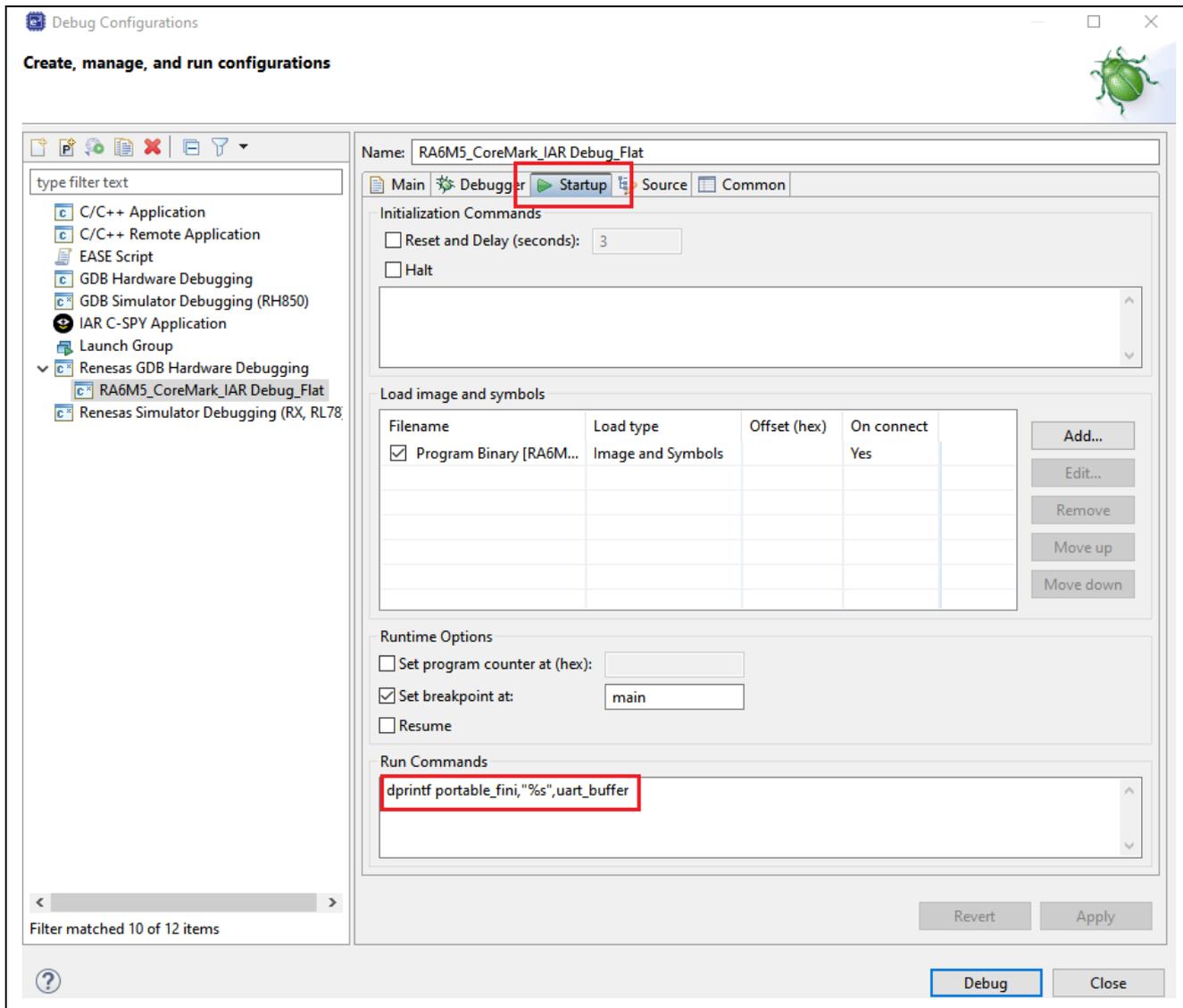


Figure 39. Add dprintf Command

2.8.3 Run The e2 studio Project

After successfully building the project, it can be debugged using Renesas GDB Hardware Debugging. Right click on the project -> Debug AS -> Renesas GDB Hardware debugging or "Debug Configurations..." and choose the desired one.

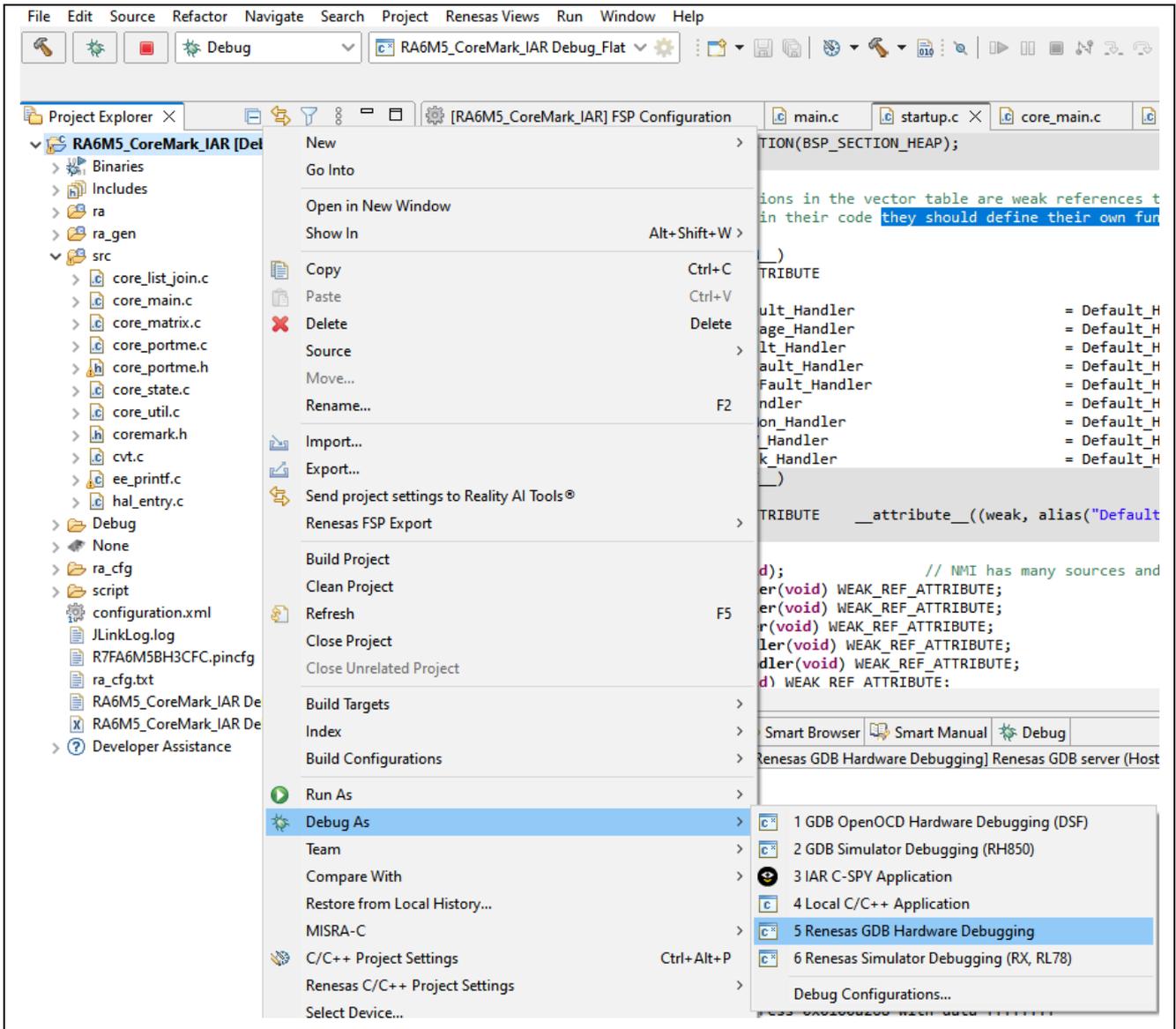


Figure 40. Debug the Project

The program should stop in the Reset_handler.

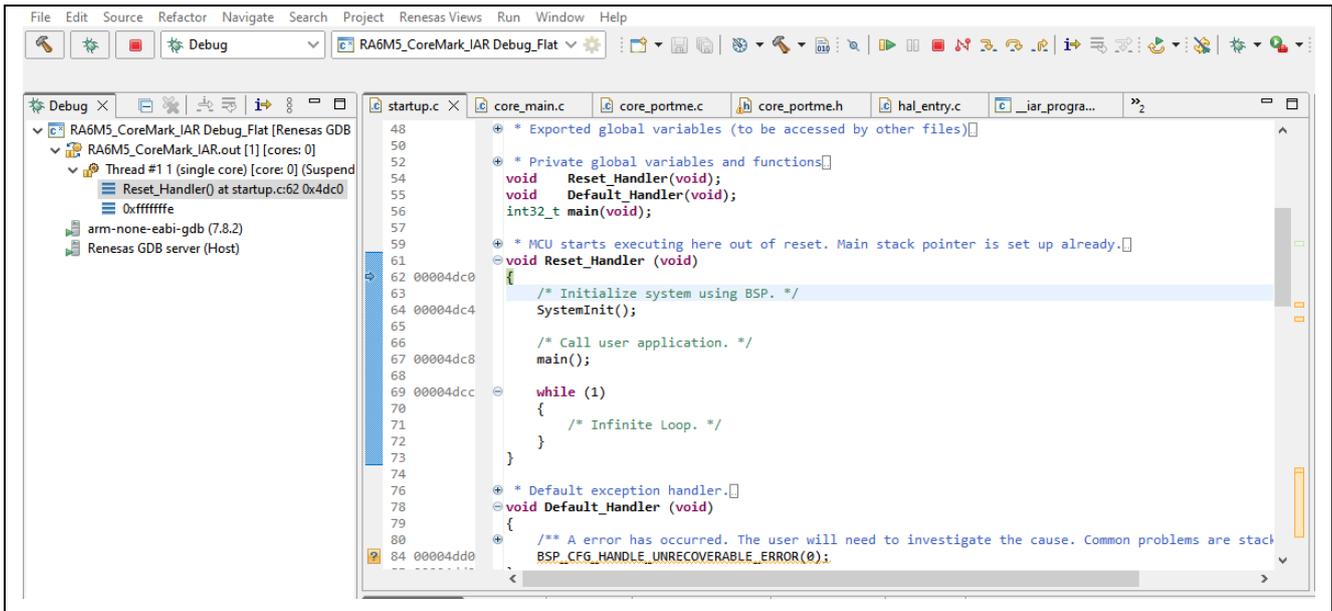


Figure 41. Debug the Project (cont'd)

Click the Resume button. The program will stop in main from core_main.c, click the Resume button again to run the project.

After a while, the program will stop in portable_fini, and the CoreMark scores will be available in the Debugger Console window, as shown below.

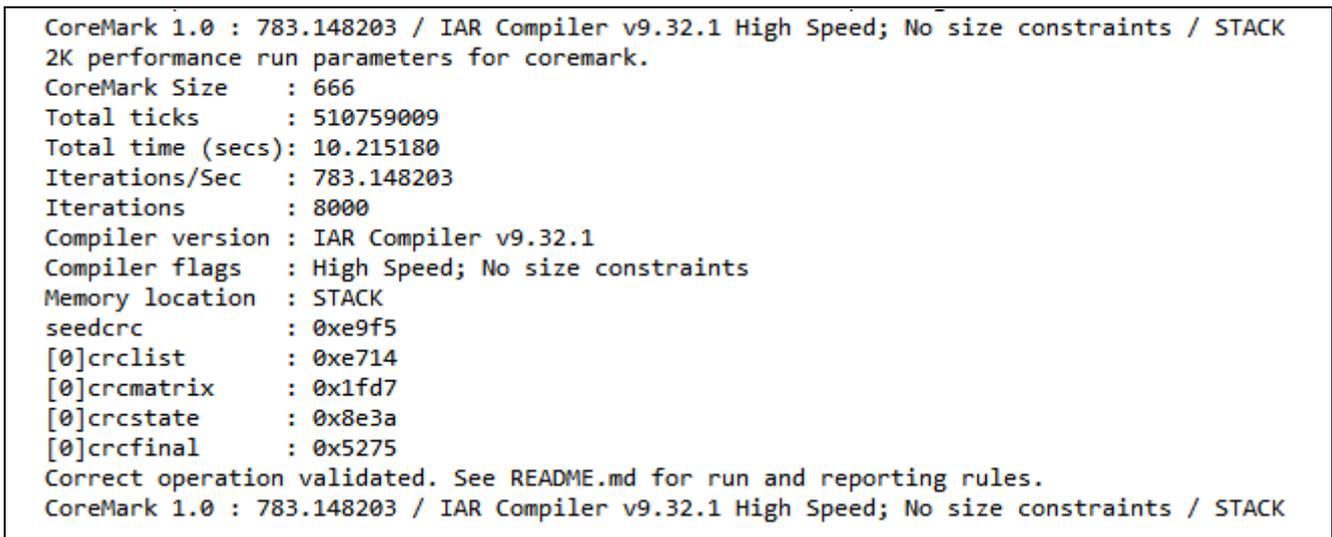


Figure 42. CoreMark Score with IAR Compiler



Figure 43. CoreMark Score with Arm Compiler

3. Verify RA Benchmarking Results

You can verify your results by referring to RA CoreMark results published on the EEMBC website, as shown below.

Clear Sel.	Vendor	Processor	Cert.	Compiler	Execution Memory	MHz	Cores	CoreMark	CoreMark / MHz	Threads	Date
<input type="checkbox"/>	Renesas Electronics	RA6T2	✓	ARM Clang Compile...	internal flash, intern...	240	1	962.45	4.01	1	2022-03-17
<input type="checkbox"/>	Renesas Electronics	RA6T2	✓	IAR C/C++ Compiler...	internal flash, intern...	240	1	950.68	3.96	1	2022-03-17
<input type="checkbox"/>	Renesas Electronics	RA2E2	✓	IAR C/C++ Compiler...	internal flash, intern...	48	1	110.24	2.29	1	2021-12-14
<input type="checkbox"/>	Renesas Electronics	RA4E1	✓	IAR C/C++ Compiler...	internal flash, intern...	100	1	386.67	3.86	1	2021-09-23
<input type="checkbox"/>	Renesas Electronics	RA4E1	✓	ARM Clang Compile...	internal flash, intern...	100	1	398.30	3.98	1	2021-09-23
<input type="checkbox"/>	Renesas Electronics	RA6E1	✓	IAR C/C++ Compiler...	internal flash, intern...	200	1	770.75	3.85	1	2021-09-23
<input type="checkbox"/>	Renesas Electronics	RA6E1	✓	ARM Clang Compile...	internal flash, intern...	200	1	790.27	3.95	1	2021-09-23
<input type="checkbox"/>	Renesas Electronics	RA6M5	✓	IAR C/C++ Compiler...	internal flash, intern...	200	1	770.82	3.85	1	2021-04-26
<input type="checkbox"/>	Renesas Electronics	RA6M5	✓	ARM Clang Compile...	internal flash, intern...	200	1	790.76	3.95	1	2021-04-26
<input type="checkbox"/>	Renesas Electronics	RA4M2	✓	ARM Clang Compile...	internal flash, intern...	100	1	398.30	3.98	1	2021-04-26
<input type="checkbox"/>	Renesas Electronics	RA4M2	✓	IAR C/C++ Compiler...	internal flash, intern...	100	1	386.00	3.86	1	2021-04-26
<input type="checkbox"/>	Renesas Electronics	RA2E1	✓	IAR C/C++ Compiler...	internal flash, intern...	48	1	111.73	2.32	1	2021-04-26
<input type="checkbox"/>	Renesas Electronics	RA6T1	✓	IAR C/C++ Compiler...	internal flash, intern...	120	1	405.90	3.38	1	2021-03-10
<input type="checkbox"/>	Renesas Electronics	RA6M4	✓	ARM Clang Compile...	internal flash, intern...	200	1	790.75	3.95	1	2021-03-10
<input type="checkbox"/>	Renesas Electronics	RA6M4	✓	IAR C/C++ Compiler...	internal flash, intern...	200	1	770.52	3.85	1	2021-03-10
<input type="checkbox"/>	Renesas Electronics	RA4M3	✓	ARM Clang Compile...	internal flash, intern...	100	1	397.30	3.97	1	2021-03-10
<input type="checkbox"/>	Renesas Electronics	RA4M3	✓	IAR C/C++ Compiler...	internal flash, intern...	100	1	386.11	3.86	1	2021-03-10
<input type="checkbox"/>	Renesas Electronics	RA2L1	✓	IAR C/C++ Compiler...	internal flash, intern...	48	1	111.73	2.32	1	2021-03-10
<input type="checkbox"/>	Broadcom Corporation	Broadcom BCM283...		GCC 7.2.1	LPDDR2 900MHz	1200	4	15363.93	12.80	4	2018-01-06

Figure 44. RA Coremark scores published on EEMBC website

4. General Guidelines for CoreMark Benchmarking

Since target devices that contain Arm processors may have a wide variety of memories and memory hierarchies, your CoreMark project should be compiled using memory correctly and efficiently. Depending on the compiler, you can achieve this by correctly editing your linker script or scatter files.

Since CoreMark is a small benchmark, it should be run multiple times to obtain reproducible numbers.

Arm recommends performing two validation runs followed by at least ten profile runs. The results can be calculated by the average for the profile runs. These steps are necessary to minimize the variation caused by inconsistent processor states.

5. References

EEMBC's CoreMark® <https://www.eembc.org/coremark/>

Website and Support

Visit the following vanity URLs to learn about key elements of the RA family, download components and related documentation, and get support.

RA Product Information	www.renesas.com/ra
RA Product Support Forum	www.renesas.com/ra/forum
RA Flexible Software Package	www.renesas.com/FSP
Renesas Support	www.renesas.com/support

Revision History

Rev.	Date	Description	
		Page	Summary
1.0	March.20.23	-	Initial version

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